

Dose/Surface Charging and Plasma Monitor (DOS/SCM) Flight Model 2—HiLET Subsystem Critical Design Review

10 April 2004

Prepared by

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This report was submitted by The Aerospace Corporation, El Segundo, CA 90245-4691, under Contract No. FA8802-04-C-0001 with the Space and Missile Systems Center, 2430 E. El Segundo Blvd, Los Angeles Air Force Base, CA 90245. It was reviewed and approved for The Aerospace Corporation by J. A. Hackwell, Principal Director, Space Science Application Laboratory. Michael Zambrana was the project officer for the Mission-Oriented Investigation and Experimentation (MOIE) program.

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Michael Zambrana
SMC/AXE

REPORT DOCUMENTATION PAGE			Form Approved OMB No. 0704-0188	
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1. REPORT DATE (DD-MM-YYYY) 10-04-2004	2. REPORT TYPE		3. DATES COVERED (From - To)	
4. TITLE AND SUBTITLE Dose/Surface Charging and Plasma Monitor (DOS/SCM) Flight Model 2 —HiLET Subsystem Critical Design Review			5a. CONTRACT NUMBER FA8802-04-C-0001	5b. GRANT NUMBER
			5c. PROGRAM ELEMENT NUMBER	
6. AUTHOR(S) J. E. Mazur, W. R. Crain, C. N. Camacho, A. Y. Lin, D. J. Mabry M. Van Dyke, E. Pierre-Louis, and M. Papadopolous			5d. PROJECT NUMBER	5e. TASK NUMBER
			5f. WORK UNIT NUMBER	
7. PERFORMING ORGANIZATION NAME(S) AND ADDRESS(ES) The Aerospace Corporation Laboratory Operations El Segundo, CA 90245-4691			8. PERFORMING ORGANIZATION REPORT NUMBER TR-2004(8570)-2	
9. SPONSORING / MONITORING AGENCY NAME(S) AND ADDRESS(ES) Space and Missile Systems Center Air Force Space Command 2450 E. El Segundo Blvd. Los Angeles Air Force Base, CA 90245			10. SPONSOR/MONITOR'S ACRONYM(S) SMC	
			11. SPONSOR/MONITOR'S REPORT NUMBER(S) SMC-TR-04-10	
12. DISTRIBUTION/AVAILABILITY STATEMENT Approved for public release; distribution unlimited.				
13. SUPPLEMENTARY NOTES				
14. ABSTRACT This report documents the critical design review for the High Linear Energy Transfer (HiLET) instrument subsystem of the Dose/Surface Charging and Plasma Monitor Flight Model 2. The design review took place on 15 January 2004 at The Aerospace Corporation, El Segundo, CA.				
15. SUBJECT TERMS Surface charging, High Linear Energy Transfer				
16. SECURITY CLASSIFICATION OF:			17. LIMITATION OF ABSTRACT	18. NUMBER OF PAGES
a. REPORT UNCLASSIFIED	b. ABSTRACT UNCLASSIFIED	c. THIS PAGE UNCLASSIFIED		47
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Dose/Surface Charging & Plasma Monitor (DOS/SCM) Flight Model #2

HiLET Subsystem Critical Design Review

15 January 2004

01-3 INTRODUCTION

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Opening Remarks

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Purpose & Scope of CDR

- Presentation & status of HiLET (High Linear-Energy Transfer) sensors
- Unclassified
- Review covers
 - HiLET sensors
 - Attendant changes to DOS/SCM
 - Attendant changes to DOS/SCM
- We invite the audience to submit Recommendation For Action (RFA) sheets
 - Assessment of readiness for construction of HiLET flight hardware & software
 - Any other topic of interest or concern
 - Point of contact for RFAs: Christine Camacho

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CDR Agenda

Timing by main topic				Presenter
Start time	Duration (min)	Section #	Topic	
0800	5	01	Opening remarks & Introduction	Joe Mazur
0805	30	01	FM2 goals & objectives	Joe Mazur
0835	10	02	Project management & schedule	Christine Camacho
0845	40	03	System engineering	Bill Crain
0925	15	04	Mechanical design	Albert Lin
0940	40	05	Structural analysis	Enold Pierre-Louis Michael Van Dyke
1020	15		Break	
1035	10	06	Detectors	Joe Mazur
1045	30	07	Electronics design	Bill Crain
1115	20	08	Flight software	Dan Mabry
1135	20	09	Test program	Bill Crain
1155	15	10	Project programmatic	Christine Camacho
1210	5	11	Closing remarks	Joe Mazur

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CDR Checklist

- The HILET CDR will demonstrate:
 - Understanding of performance and interface requirements
 - Understanding of mission environment
 - Risk management processes
 - Understanding of reliability & workmanship policies & application
 - Adequacy of design concept & implementation
 - Adequacy of technical resources (mass, power, volume)
- The HILET CDR will specify our approaches to:
 - Long-lead items
 - Radiation
 - EMI
 - Pressure venting
 - ESD sensitivity & precautions
 - Handling

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Project Review History

- Project Initiation Management Review 4/17/2003
 - This was an Aerospace internal review
 - Covered the total FM2 project management structure & funding
 - Result: project go-ahead
- No CoDR or PDR due to tight schedule

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Aerospace HEO Investigations - the Beginning

- Between 1983 and 1989 Aerospace, with the help of Sandia colleagues, measured the dose in HEO orbit under 100 mils of aluminum with a simple, single channel, slab-geometry sensor. Two flights were made.
- The series of observations indicated that: "...the AE-8 model substantially over-predicts the dose received in a HEO orbit under ... 100 mils of aluminum."
 - *J. B. Blake and J. E. Cox 1989, AIP Conference Proceedings 186, AIP, New York.*
 - *J. B. Blake 1990, ESA Workshop Proceedings WPP-23, Noordwijk*

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FM2 Goals & Objectives

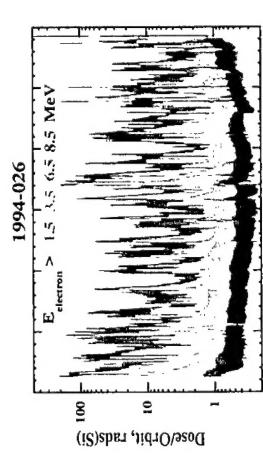
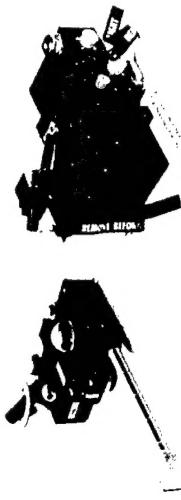
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Further Investigations of the HEO Environment

- 1994-026
 - 4 dosimeters, solid-state detector telescope, & magnetometer
- 1995-034
 - 1 dosimeter, telescope, plasma analyzer, & dual magnetometers
- 1997-068
 - 4 dosimeters & solid-state detector telescope

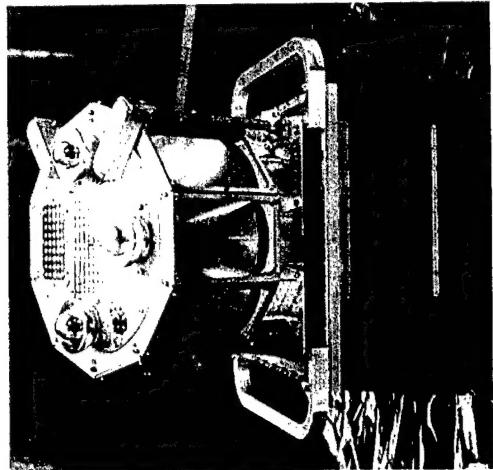


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DOS/SCM FM1

- Measurements:
 - Electrons
 - 10 eV to 30 keV
 - >300 keV, 1.4 MeV, & 2.5 MeV
 - Protons
 - 10 eV to 30 keV
 - >8, 15, & 26 MeV
- Dose under 11 mils Mg, 49.5, & 126 mils Al
- Delivered November 2002
- Currently in calibration & test
- Redelivery February 2004

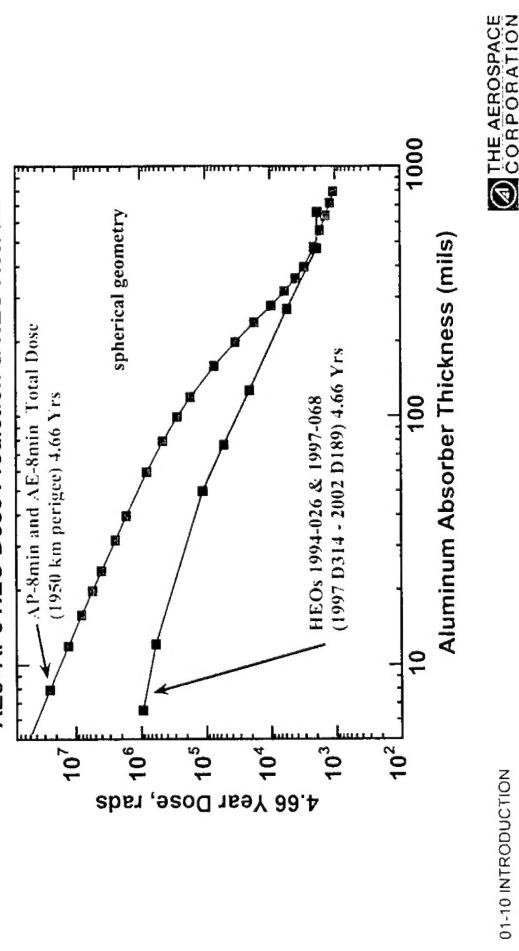


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HEO Observations Versus Universally Used Models



AE8+AP8 HEO Dose Prediction & HEO Actuals



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FM2 Project Goals and Objectives

- Goals
 - Modify FM1 design to provide energetic ion spectra for improving decades-old environment models, to support solar array design, and to improve SEE specification & prediction
 - Responding to evolving interests of Aerospace customers (in particular, MEO orbits)
 - To be done within spacecraft resources allocated to FM1
 - Deliver flight-worthy FM2 to TWINS-2 host in FY04
- Primary Objectives
 - Fabricate, test, and calibrate the SCM
 - Develop, fabricate, test, and calibrate the High-Linear Energy Transfer ion Telescope (HiLET)

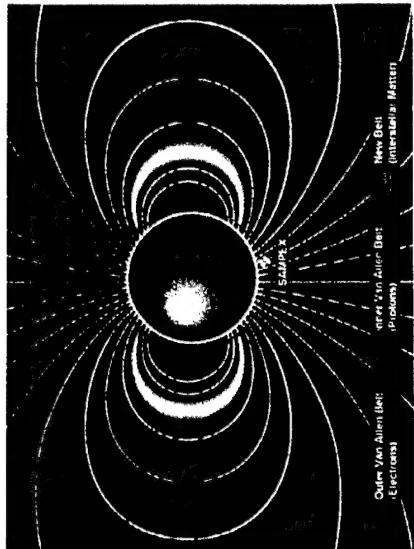
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Environment Issues: New Radiation Belts

- Transient radiation belts due to
 - Anomalous cosmic rays
 - Shock-injected particles during intense solar proton events

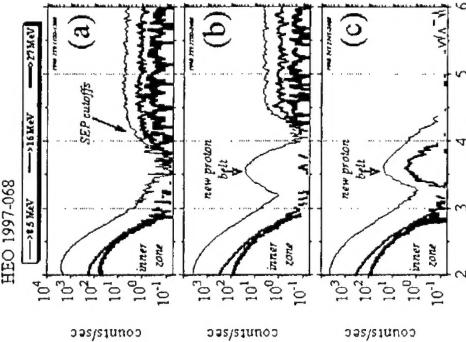


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Environment Issues: New Radiation Belts

- No radiation models adequately specify new belts that are shock-related
- Several processes may be responsible for their creation.
 - Their properties have only been glimpsed with recent missions (e.g. 24 March 1991 observed with CRRES, Blake et al. 1992; Li et al. 1993).

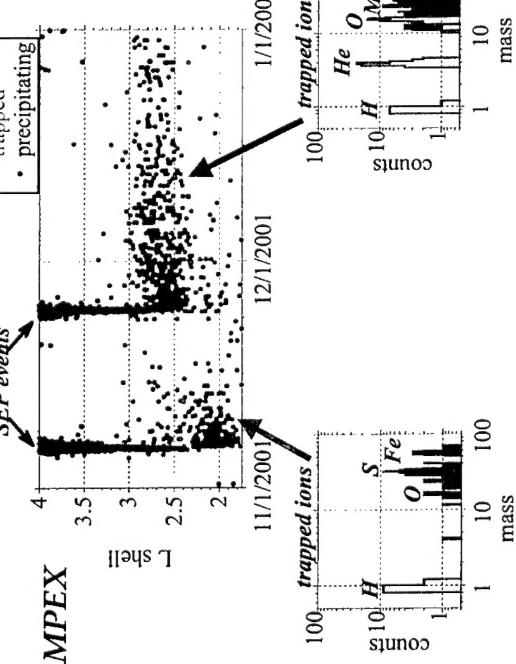


-example of a new belt that formed after the shock/SEP event of 24 Aug. 1998

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New Belts: Variable Heavy-ion Composition

- trapped
- precipitating

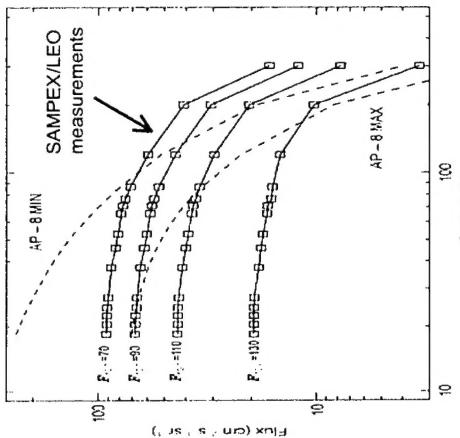


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Proton energy spectra - discrepancies with AP-8

- Observed proton spectra in the inner zone are markedly different from model
- CRRES observations (< 100 MeV) also showed flatter proton spectra
 - Analysis difficult with large corrections necessary - illustrates difficulty analyzing inner zone measurements
 - Gussenhoven et al. 1993, Trans. Nuc. Sci. 40, 1450



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Breakdown of DOS/SCM FM2 Requirements

FM2 project requirement	SCM	HiLET
Provide measurements of the space environment that directly relate to:		
surface charging	✓	✓
penetrating radiation	✓	✓
total dose	✓	✓
radiation belt dynamics	✓	✓
Provide direct environmental support to the host vehicle	✓	✓
Gather data needed to develop environmental models and specifications for future programs	✓	✓

01-17 INTRODUCTION

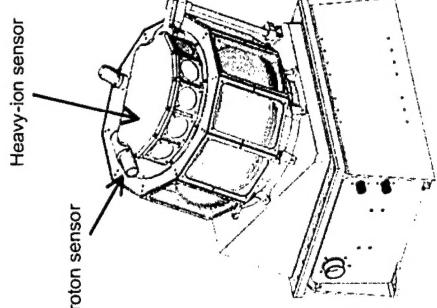
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HiLET

- HiLET uses particle-detection and analysis techniques that are similar to sensors flown on previous HEO missions, but HiLET is much more capable
- Uses new technologies developed for NASA/STEREO mission
 - Caltech PHASIC 16-channel amplifier chips (3)
 - Micron Semiconductor Ltd. solid-state detectors
- Caltech support to HiLET verified in meeting with Prof. E. Stone & SRL staff on 3/25/2003
- Project continues long-standing Aerospace collaboration with space scientists at Caltech & JPL

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HiLET Requirements - 1

HiLET heavy-ion telescope parameter	Performance requirement	Motivation
Geometric factor	$> 1 \text{ cm}^2 \text{sr}$	Due to falling spectra, need large geometry factor to get sufficient statistics at highest LET
Energy range (MeV/nucleon)	$3 - 70 (Z = 26)$	Threshold as low as possible for analysis of surface effects; maximum energy to penetrate at least 80 mils Al.
Particle species measured	$6 \leq Z \leq 26$	No light-ion analysis to provide immunity from pile-up & high dead-time in radiation belts
FOV	Wide acceptance (>45 degrees)	Includes perpendicular pitch angles at low-L without detailed pointing requirements
Mass resolution (sigma amu)	$< 0.5 \text{ amu}$ (elemental resolution)	Largest contributions to LET spectrum come from most abundant, even-Z elements
Event analysis rate	20 events/sec	Telemetry all $Z \geq 6$ ions in 7/14/2000 SEP event

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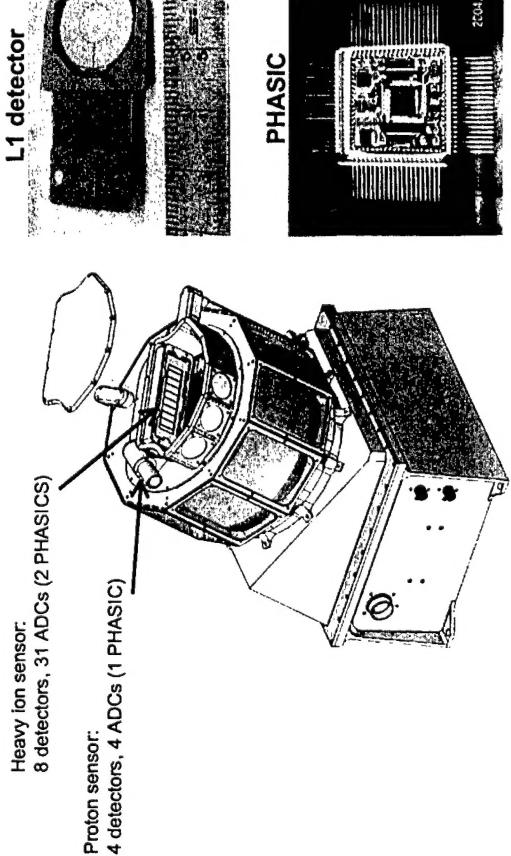
HiLET Requirements - 2

HiLET proton telescope parameter	Performance requirement	Motivation
Geometric factor	$10^{-2} \text{ to } 10^{-3} \text{ cm}^2 \text{sr}$	Sufficient for peak intensities in radiation belts & SEP events
Energy range	6-20 MeV (protons)	Proton ranges ~10-100 mils Al
Particle species measured	Protons (with goal to include alphas and >0.5 MeV electrons)	Highest range; continuity with previous SSAL measurements of ~0.5 MeV electrons in outer zone
FOV	Collimated aperture; overlap with HiLET ion telescope	Minimize scattering of electrons into FOV; simultaneous FOV coverage of all ion species
Event rate	Onboard collection of ≥ 8 spectral bins, one spectrum per second	Sufficient for proton spectrum in inner zone
PHA events	Periodic transmission of full PHA events	Ground-based check of on-board binning

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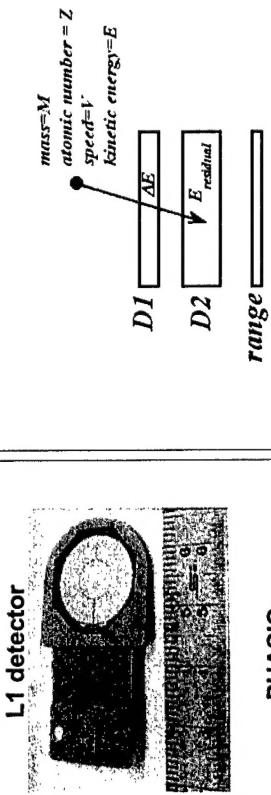
HiLET Major Components



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HiLET Measurement Principle

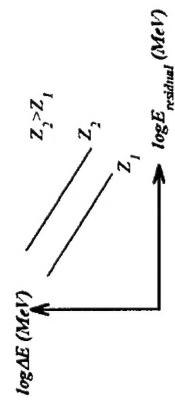


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$$E\Delta E \propto MZ^2$$

$$\Delta E \approx \frac{dE}{dx} \Delta x \propto \frac{MZ^2}{E} \Delta x$$

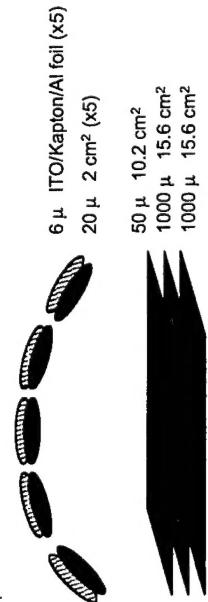


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HiLET Detector Stacks

Heavy-ion sensor



20000 Å Al solar-blind window

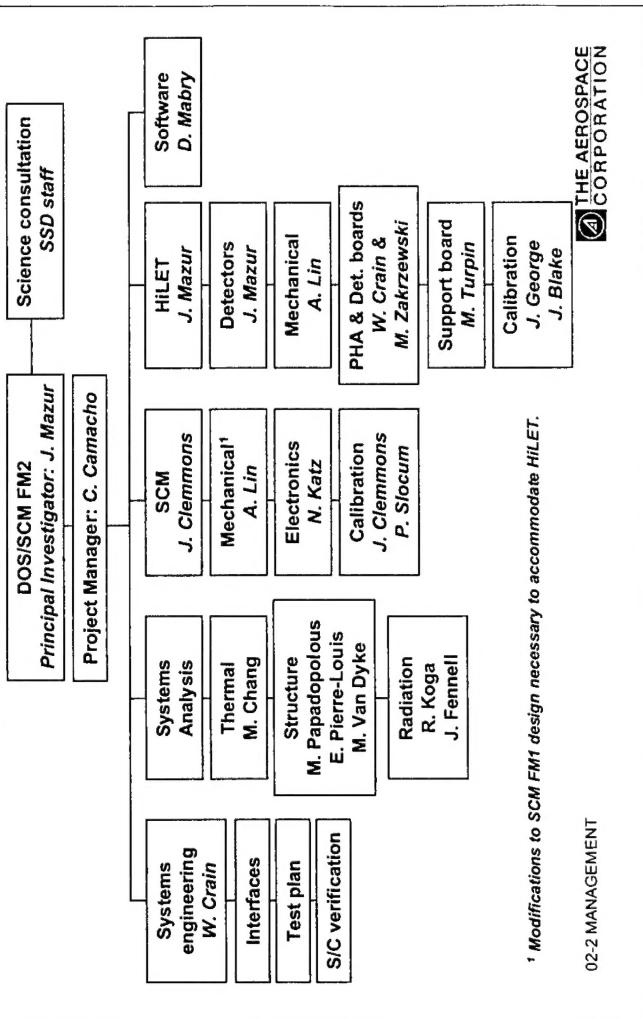
Representative energy ranges:

- Oxygen: 2.7-40 MeV/nucleon
- Protons: 6.5-18.5 MeV
- Electrons: 0.25-1.2 MeV

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Project Organization

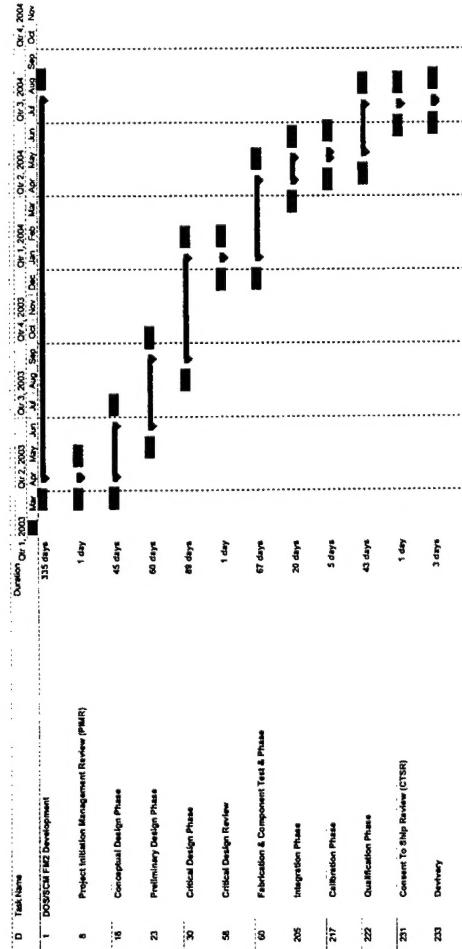


Project Management & Schedule

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02-1 MANAGEMENT

DOS/SCM FM2 Schedule



02-3 MANAGEMENT

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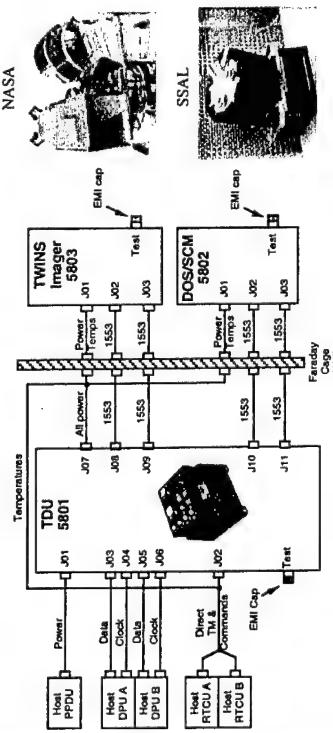
System Engineering

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03-1 SYSTEM

Payload Configuration

- DOS/SCM is part of the TWINS/ES payload
- Interface to S/C is through TDU



DOS/SCM Flight Model 2 Changes

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- Changes to FM1 and Impact Assessment
- Requirements Flowdown
- Concept of Operations
- Power and Mass Reserves
- Documentation
- Contamination, Safety, and Handling
- EMI Design
- Thermal Design
- Radiation & Charging Mitigation
- Summary

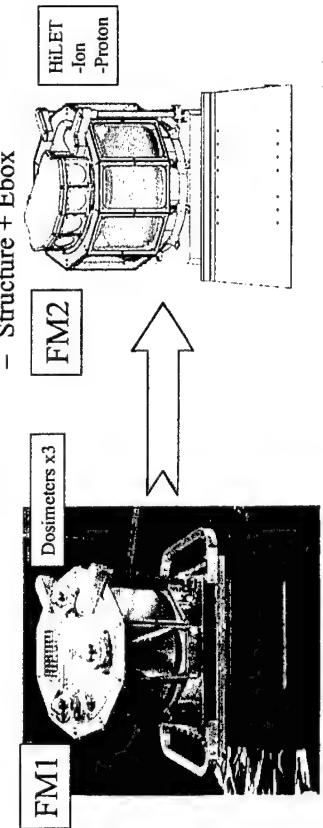
03-2 SYSTEM

Overview

- Changes to FM1 and Impact Assessment
- Requirements Flowdown
- Concept of Operations
- Power and Mass Reserves
- Documentation
- Contamination, Safety, and Handling
- EMI Design
- Thermal Design
- Radiation & Charging Mitigation
- Summary

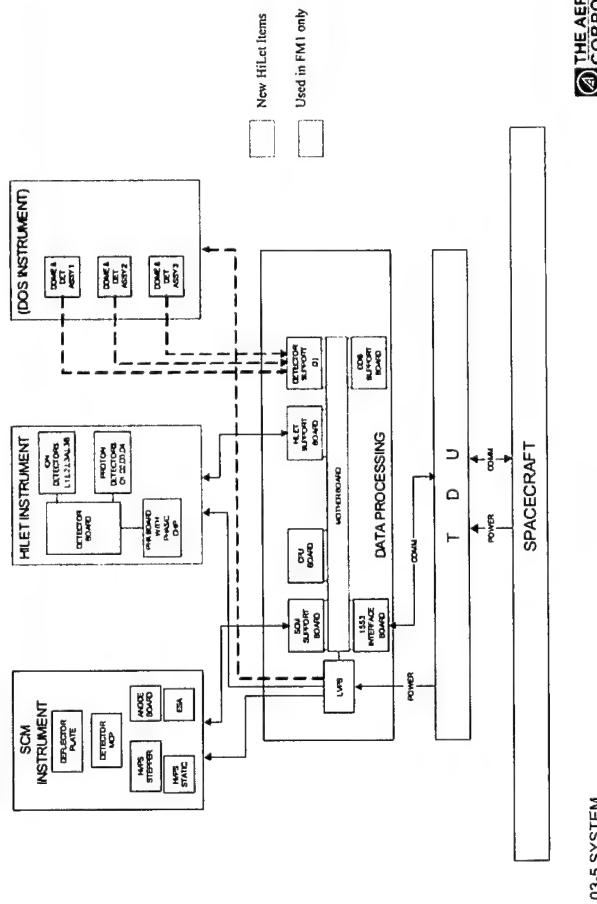
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- **Hardware Changes**
 - Remove Dosimeters
 - Add HiLET sensors
 - Change motherboard
 - Add CPU I/F board (HiLET Support Board)
- **Hardware Unchanged**
 - Power supplies (LV & HV)
 - CPU board
 - 1553 board (TDU I/F)
 - SCM plus electronics
 - S/C interface



DOS/SCM Block Diagram

Impact Summary



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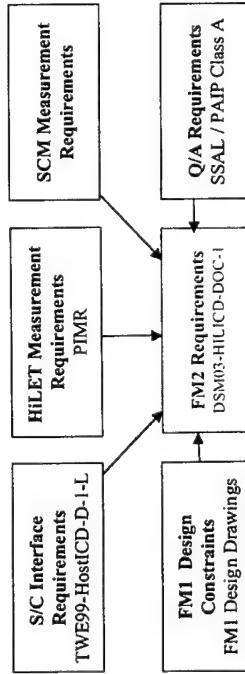
Category	Technical Impact	Level
Structural Analysis	Created new FEM model; modal & stress analyses performed	Medium
TDU FM2	New telemetry data packet for HiLET; increased operational duty cycle	Medium
Flight Software	Add HiLET telemetry data packets; event selection algorithm; commands	Medium
S/C ICD	Reallocate power & mass to DOS/SCM; no other changes necessary	Medium
EMI	Added noise sources that have potential to affect radiated emissions signature	Low
Thermal Analysis	Updated model and hot/cold predictions	Low
I&T Procedures; Operations	New commands to be added to existing procedures and ground station databases	Low
SCM Performance	No change to measurement specifications, timing, or data bandwidth	Zero
FMEA	No change to S/C electrical interface designs	Zero

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Requirements Flowdown

- FM2 requirements for HiLET sensor documented
- Requirements for Host accommodation unchanged (except for new commands to database)
- SCM measurement requirements unchanged
- Quality Assurance requirements per SSAL Product Assurance Implementation Plan Class A



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Measurement Requirements (1/2)

- Geometric Factor (1 cm²sr)
 - Mechanical
 - Detector active area
 - Mass Resolution (<0.5 amu)
 - Detector thicknesses
 - PHA board preamp gains
 - Particle Species (6 < Z <26)
 - Detector thicknesses
 - PHA board coincidence
 - PHA board E-thresholds
 - Detector board layout
 - Event Rate (1 kHz PHA Events)
 - PHA board electronic noise
 - PHA board layout
 - Detector board layout
 - Event Rate (1 kHz PHA Events)
 - Detector resolution
 - Thermal design
- Field-of-View (> 45 deg)
 - Mechanical
 - S/C Accommodation
- Energy Range (3 – 70 MeV/n for iron)
 - Mechanical
 - Detector active area
 - Mass Resolution (<0.5 amu)
 - Detector thicknesses
 - PHA board preamp gains
 - Particle Species (6 < Z <26)
 - Detector thicknesses
 - PHA board coincidence
 - PHA board E-thresholds
 - Detector board layout
 - Event Rate (1 kHz PHA Events)
 - PHA board electronic noise
 - PHA board layout
 - Detector board layout
 - Event Rate (1 kHz PHA Events)
 - Detector resolution
 - Thermal design

Measurement Requirements (2/2)

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Measurement Requirements (2/2)

- Geometric Factor ($10^{-2} - 10^{-3}$ cm^2sr)
 - Field-of-View (aligned to Ion)
 - Mechanical
 - S/C Accommodation
 - Detector active area
 - PHA board coincidence
 - PHA board gains
 - Particle Species (Protons, Electrons > 500 keV)
 - PHA board thicknesses
 - PHA board coincidence
 - PHA board E-thresholds
 - PHA board layout
 - Thermal design
- Energy Range (6 – 20 MeV)
 - Detector thicknesses
 - PHA board coincidence
 - PHA board gains
 - Support board interface
 - Software / Telemetry
 - Event Rate (1 kHz in Spectral Bins)
 - PHA board readout FPGA
 - PHA board event memory
 - Support board interface
 - Software / Telemetry
 - Event Rate (1 kHz PHA Events)
 - PHA board readout FPGA
 - PHA board event memory
 - Support board interface
 - Software / Telemetry

Proton Telescope

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S/C Interface Requirements

- 44 ICD requirements apply to DOS/SCM
- HiLET designed in scope of the DOS/SCM FMI interface accommodation
 - Exception: reallocation of mass and power budgets needed to maintain acceptable margin going into build phase
 - No change to envelope, FOV, mounting, or electrical
- Changes to verification products
 - 20 requirements will have new verification procedures
 - 24 verification products from FMI unaffected

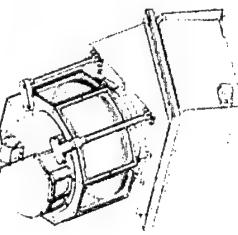
S/C Interface Verification Matrix (1/3)

Physical Properties and Resource Requirements Summary

Physical Properties / Resources	Spacecraft ICD Requirement	FMI2 Design w/ HiLET		Compliance Status @ CDR	Final Verification Method
		Comply	Non-comply		
TWES 3103 - Power Budget	No change	Comply	Non-comply	ANALYSIS - FMEA	TEST
TWES 3103 - Envelope	Increased height	Comply	Non-comply	INSPECTION	TEST
TWES 3103 - Weight NTE 15 lbs	Actual weight	Non-comply	Non-comply	DEMONSTRATION	TEST
TWES 3103, 3115 - Center of Gravity +/- 0.25 in. tick	Actual CG location	Comply	Non-comply	TEST	TEST
TWES 3103 - provide MOI & Polar moments uncertainty	Calculated MOI / POI	Comply	Non-comply	ANALYSIS - FMEA	TEST
TWES 3103 - Power NTE 13.5 Watts	Actual power	Non-comply	Non-comply	ANALYSIS - FMEA	TEST
TWES 3142 - Standby Power NTE 0 Watts	Estimated DOS power	Non-comply	Non-comply	ANALYSIS - FMEA	TEST
TWES 3142 - Transfer Onboard Power NTE 0 Watts	Estimated DOS power	Non-comply	Non-comply	ANALYSIS - FMEA	TEST
TWES 3203 - Payload D	No change	Comply	Non-comply	INSPECTION	TEST
TWES 3403 - Verif	Actual verif path	Comply	Non-comply	INSPECTION	TEST
TWES 3403 - Outgassing TRL 1 / Cycles	Non-compliant	Non-comply	Non-comply	INSPECTION - Materials Lab	TEST

Other Design Constraints

- HiLET pointing constrained by mechanical features
- HiLET board sizes and spacing constrained by envelope and SCM hemispheres
- Limited electrical interface options between HiLET and Electronics Box CPU
- Mass limited by stress margins and existing budget
- Power limited by budget and to a lesser extent by thermal
- Low voltage power supply
- Limited telemetry bandwidth
- PHA board readout FPGA
- PHA board event memory
- Support board interface
- Software / Telemetry
- Event Rate (1 kHz PHA Events)
- PHA board readout FPGA
- PHA board event memory
- Support board interface
- Software / Telemetry



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S/C Interface Verification Matrix (2/3)

S/C Interface Verification Matrix (3/3)

Mechanical and Electrical Requirements Summary

EMI / ESD Requirements Summary

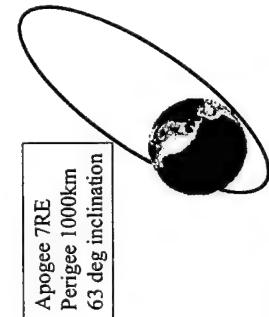
Mechanical		Electrical	
TWES 400 - Surface Flawless	No change	Comply	TEST
TWES 400 - Connections	No change	Comply	INSPECTION
TWES 410 - Shielded effects > 70 Hz	New structural model	Comply	ANALYSIS / TEST - Structure Analysis (NA/CE)
TWES 4105 - Structural Stress: Possible Margin of Safety	New structural model	Comply	ANALYSIS / TEST - Structure Analysis (FEM)
TWES 5200 - Direct Tolerance Output Requirements	No change	Comply	ANALYSIS - Failure Mode & Effects Analysis
TWES 5400 - SCD Power Thresholds	No change	Comply	TEST
TWES 6000 - Acoustic Pressure	Structural detector rate	TBD	TEST - Acoustic Test
TWES 6070 - Static Pressure	New analysis	Comply	ANALYSIS
TWES 6000 - Dynamic Pressure	New analysis	Comply	ANALYSIS

03-13 SYSTEM

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Concept of Operations (1/2)

- 100 % operational duty cycle
- Mission life is 10 years
 - No life limiting materials
 - Designed for 10-year total dose
- Normal mode
 - 3 kbps data rate
 - No routine commanding
- Maintenance mode
 - Infrequent
 - Existing mode on DOS/SCM for uploads
 - HiLET configuration changes (PHASIC settings)
- In-flight calibration ops
 - Bi-weekly (to be timed with SCM)
 - Supports detector leakage current and test pulser functions



Concept of Operations (2/2)

- New ground commands needed to support HiLET
 - HiLET Detector Bias On/Off
 - HiLET Pulser On/Off
 - HiLET Pulser Level (8-bit variable)
 - HiLET Calibration On/Off
- Memory Uploads
 - Same upload command structure as FMI
 - HiLET Proton Matrix Lookup Table (64 kbytes)
 - HiLET PHASIC Configuration Data (~320 bytes)

03-14 SYSTEM

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03-15 SYSTEM

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03-16 SYSTEM

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Power Margin

On-Orbit Power Profile

- Total FM2 TWINS/ES power complies with ICD with added uncertainty margins (10% CDR, 3% un-built, 0% delivered)
- Small negative margin on DOS/SCM unit power for FM2

TWINS/ES Unit	ICD Budget (Watts)	FM1 measured (Watts)	FM2 at CDR (Watts)	Anticipated Uncertainty Margin	FM2 final (Watts)	Margin	Total
DOS/SCM	13	13.2	13.3	10%	14.6		
TWINS	27	26.5	26.5	3%	27.3		
TDU	4	2.60	2.80	0%	2.80		
Heaters	30	27	27	3%	27.8		
TOTAL	74	69.3	69.6		72.5		

03-17 SYSTEM

S/C Operational Mode						
FM2 TWINS/ES Units	Unit Budgets	Full Ops	Reduced Ops (RadBelts)	Standby 1	Standby 2	Transfer
TWINS	27	26.5	24.2	13.4	0.0	0.0
DOS/SCM	13	13.3	8.4	8.4	8.4	0.0
DPU/Ebox		6.1	6.1	6.1	6.1	0.0
HILET		2.3	2.3	2.3	2.3	0.0
SCM HV		4.9	0.0	0.0	0.0	0.0
TDU	4	2.8	2.8	2.8	0.0	0.0
Heaters	30	27.0	29.3	34.9	34.9	8.6
Total Power S/C ICD NTE Rqmt. Margin	69.6	69.6	59.5	59.5	43.3	3.6
		74.0	74.0	74.0	74.0	35.0
		6.4%	6.4%	6.4%	6.4%	-19.2%
						-27.9%

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- No changes to on-orbit operational power profile from FM1
- Negative margin on FM2 Standby 2 also problematic on FM1 and is being accommodated by S/C with additional 8.3 W

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Mass Margin

- Total FM2 TWINS/ES mass complies with ICD with added uncertainty margins (10% CDR, 3% un-built, 0% delivered)
- No existing margin on DOS/SCM unit mass budget for FM2

TWINS/ES Unit	ICD Budget (lbs)	FM1 measured (lbs)	FM2 at CDR (lbs)	Anticipated Uncertainty Margin	FM2 final (lbs)
DOS/SCM	15	13.7	14.9	10%	16.4
TWINS	47	42.1	42.1	3%	43.4
TDU	5	4.32	4.63	0%	4.63
TOTAL	65	60.1	61.6		64.4

Documentation (1/4)

- Configuration Control
 - All drawings (including schematic diagrams) that are generated, relative to fabrication or assembly of deliverable product, are controlled
 - Controlled drawings are maintained by the Quality Assurance Manager in accordance with project requirements
 - Controlled documents require an Engineering Change Order (ECO) for red-line modifications
 - Document revisions are controlled by the Aerospace document *Product Assurance Project Configuration Control*
 - Formal Configuration Control of fabrication/assembly drawings will begin no earlier than the completion of CDR

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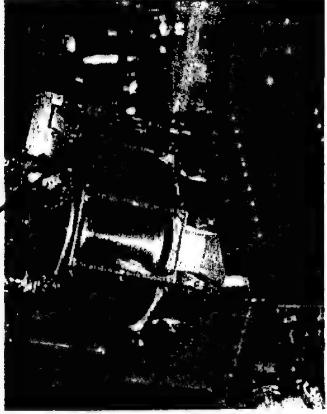
Safety and Handling

- Delicate surfaces not to be touched
 - Delicate HiLET detector assembly has thin foils which can be damaged from poor handling
 - SCM aperture has very delicate EMI screens
 - ITO thermal control surfaces will degrade thermally and electrically if touched
- Total instrument lifting weight is \sim 16 lbs
 - Includes lift handles and protective covers
- High voltage
 - 5000 volts on SCM aperture as in FMI
 - HiLET voltage $<$ 300 volts and not externally accessible
- No pyrotechnic devices or deployable systems

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03-25 SYSTEM

EMI Radiated Emissions

- Undesirable RF power at highest impedance level requires careful attention (32MHz oscillator)
- U/F conduit surface impedance and shield termination is key and should require no changes
- EMI design of HiLET
 - Minimize digital noise in upper PCBs
 - Slow differential serial interface to electronics box
 - 100% shielded design
 - Maintain tight seams (\sim 1-inch screw spacing)

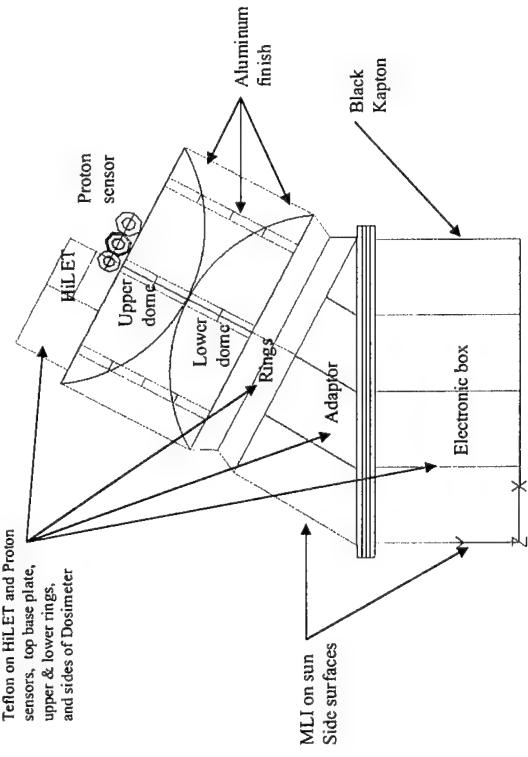


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03-26 SYSTEM

Thermal Design

- Aerospace Thermal Department
 - Design and analysis by M. Chang and T. Dickey
- No changes from basic FM1 thermal design
 - Relies on absorption and emissivity of thermal surfaces
 - No heaters
 - No active cooling
- Sensors and boards are hard mounted
- Surface finishes
 - Black Kapton on anti-sun side of electronic box
 - MLI on sun-sides of electronic box and triangle adaptor
 - All other surfaces covered with ITO silvered Teflon tape

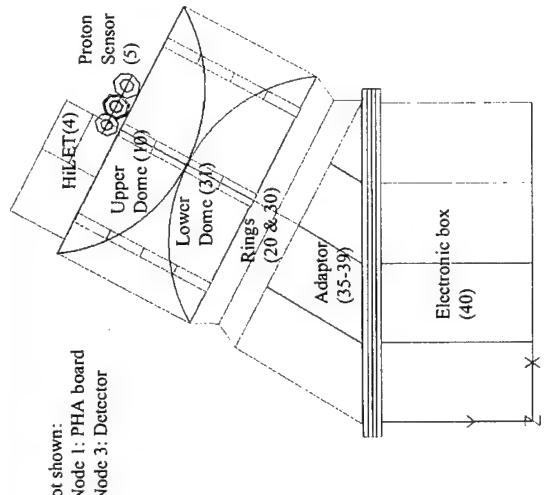


Thermal Model (1/4)

Thermal Model (2/4)

- 30 nodes
- Hot case assumptions:
 - Beta angle = 0°, Winter, solar flux is 444 Btu/hr/ft²
 - End of life physical properties
 - Spacecraft is at 100°F
- Cold case assumptions:
 - Beta angle = 40°, Summer, solar flux is 415 Btu/hr/ft²
 - Beginning of life physical properties
 - Spacecraft is at 60°F
 - Transfer orbit assumptions:
 - All units powered off
 - Beginning of life physical properties
 - Spacecraft is at 60°F

03-29 SYSTEM



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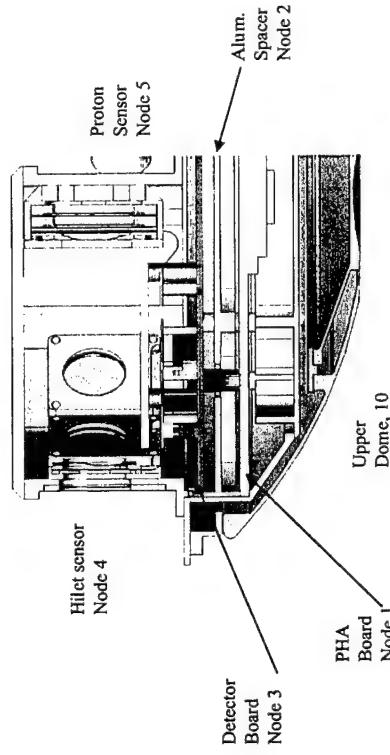
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03-30 SYSTEM

03-31 SYSTEM

Thermal Model (4/4)

HiLET Thermal Model Detail

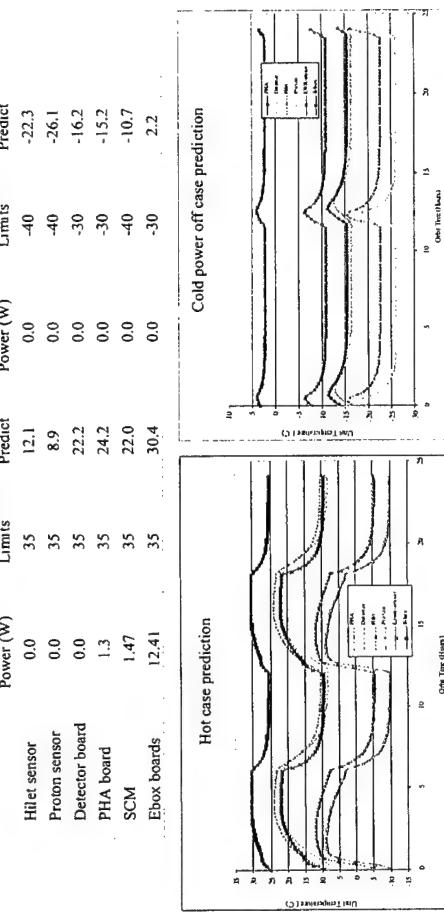


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03-32 SYSTEM

Thermal Predictions – Normal Orbit

Hot/cold predictions demonstrate good margin on limits



Note: Lower Sensor = SCM

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Thermal Model (3/4)

Thermal Predictions – Transfer Orbit

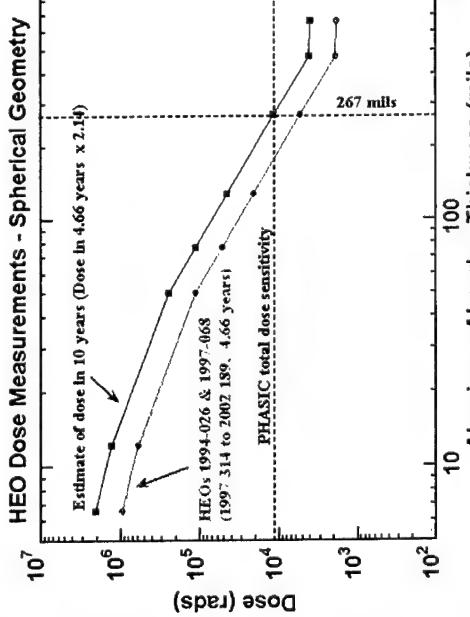
Transfer orbit temperatures are safely within cold limits

Unit	Power (W)	Limits (°C)	Transfer orbit Predict (°C)
Hillet sensor	0.0	-40	-20.3
Proton sensor	0.0	-40	-23.9
Detector board	0.0	30	-14.7
PHA board	0.0	-30	-13.5
SCM	0.0	-40	-9.5
Ebox boards	0.0	-30	2.7

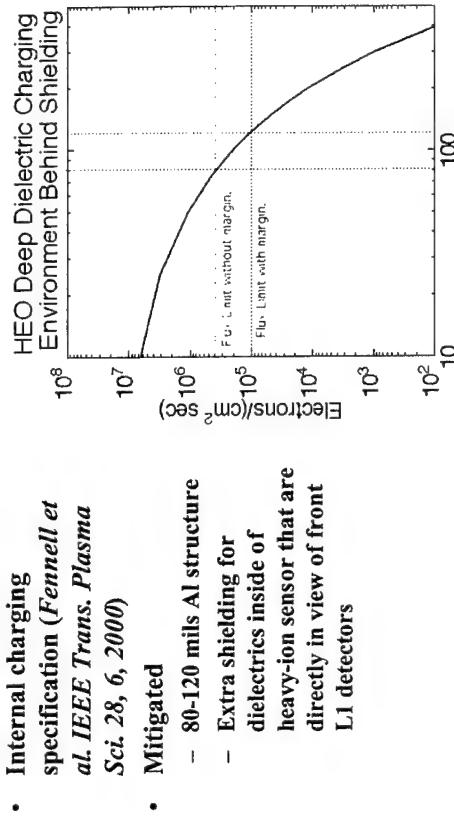
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Total Dose Environment



HEO charging environment



- Internal charging specification (Fennell et al. *IEEE Trans. Plasma Sci.* 28, 6, 2000)
- Mitigated
 - 80-120 mils Al structure
 - Extra shielding for dielectrics inside of heavy-ion sensor that are directly in view of front L1 detectors

Radiation Design

- Total dose design based on HEO measurements to date, extrapolated to 10-year mission
 - Procured microcircuits to 100 Krad hardness
 - Implemented spot shields for PHASIC protection
 - Single event effects mitigated by component test data
 - No latchup susceptibilities including PHASIC chip
 - SEU test data indicates < 1 error over mission
 - Deep-dielectric and surface charging mitigated by shielding, materials selection, and grounding
 - Applied Frederickson safe flux level guidelines
 - Incorporated thicker shielding around backside of detectors to further reduce electron flux
 - No internal or external floating conductors

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After HEO Data, Prod. No. Dose-1997-OPC

Summary

- HiLET sensor can be accommodated with minor technical impact on FM1 system design
 - No changes to spacecraft mechanical and electrical interfaces
 - No impact on SCM performance
- No failure modes have been added that would affect Host mission
- Revision of DOS/SCM operating procedures will be necessary to support HiLET
 - Mass and power budgets under review

Mechanical Design Requirements

- Comply with S/C ICD
 - Mass Properties
 - Envelope
 - Venting
 - EMI
 - Structural
- No changes to SCM or E-box mechanical designs
- Provide stand-alone capability (HiLET & SCM)
- Meet HiLET FOV and geometric factor requirements
- Mitigate radiation and charging hazards

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Mechanical System Design

Albert Lin

Albert.Y.Lin@aero.org

310-336-1023

04-2 MECHANICAL

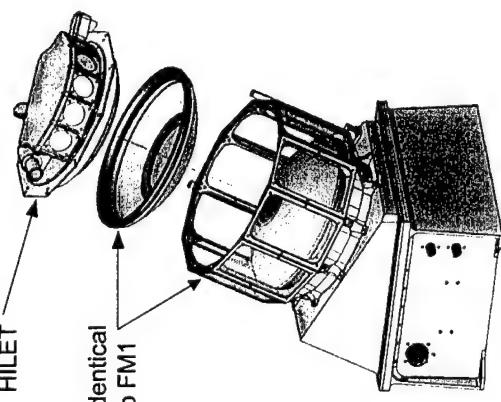
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Albert.Y.Lin@aero.org
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04-1 MECHANICAL

Mechanical Overview (2/2)

- HiLET mounts onto structure that is identical to FM1
- S/C mounting interface is unchanged
- SCM packaging and internal harness are identical to FM1
- Heavy ion telescope
- Proton telescope
- Detector board
- PHA board
- 0.080" wall thickness to mitigate internal charging
- All cables are internally routed to reduce EMI



04-3 MECHANICAL

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04-4 MECHANICAL

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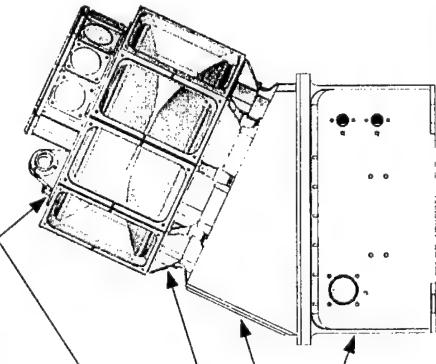
Mass Properties (1/2)

- Total weight is 14.9 pounds
- All FM2 parts except HiLET already machined

Component	Weight (lbs)	% of FM2
HiLET	2.84	19.0%
Misc*	.39	2.7%
SCM Assy	3.90	26.1%
Wedge Assy	1.18	7.9%
E-box	6.59	44.3%
Total	14.90	100%

*Misc is conduit/cable/connector allocation

04-5 MECHANICAL



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Mass Properties (2/2)

- FM2 CG is within 1" tolerance of CG in ICD

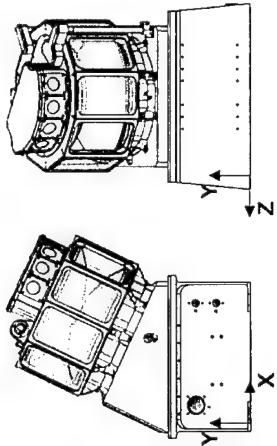
Axis	FM2	ICD	Change
X	4.47	4.44	0.03
Y	5.59	5.33	0.26
Z	-4.76	-5.74	0.98

Moments of Inertia (lb-in²)

$I_{xx} = 293$ $I_{xy} = 52$ $I_{xz} = -3$
 $I_{yx} = 52$ $I_{yy} = 176$ $I_{yz} = 1$
 $I_{zx} = -3$ $I_{zy} = 1$ $I_{zz} = 306$

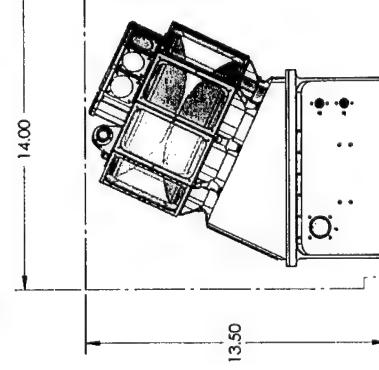
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04-6 MECHANICAL

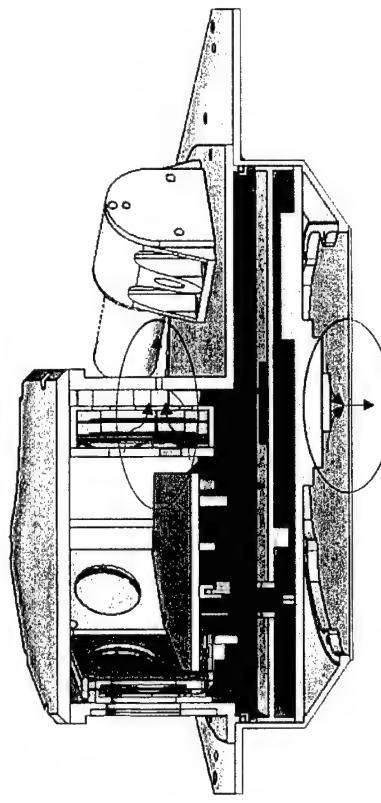


Envelope

- DOS/SCM FM2 fits within envelope



04-7 MECHANICAL



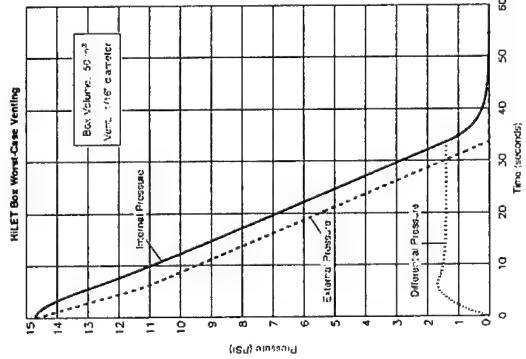
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Venting (2/2)

- 1.7 psi maximum pressure build up across enclosure walls



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- Characteristic venting time of 3.5 seconds much less than time constant for external pressure decay of 19.5 seconds

- All materials comply with <1.0% TML and <10% CVCM outgassing spec

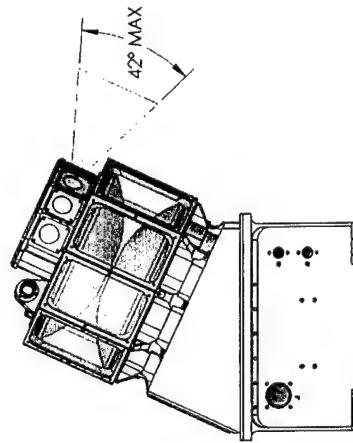
Material List

Material	TML	CVCM	Material	TML	CVCM
Aluminum 6061-T6	<0.1	<0.05	Flux RMA	0.34	<0.05
Gold Iridite Finish	<0.1	<0.05	Urethane	0.6	<0.05
Gold Plating	<0.1	<0.05	Polyimide HTE/Glass	0.82	<0.05
18-8 Stainless Steel	<0.1	<0.05	Solid, Insulated Wire	0.22	<0.05
Molybdenum Disulfide	<0.1	<0.05	Silicone Adhesive	0.2	0.03
Phosphor Bronze	<0.1	<0.05	Delrin	0.8	0.09
Tantalum	<0.1	<0.05	Lacing Tape	0.58	0.09
Silicon	<0.1	<0.05	Viton	0.21	0.02
Sintered Ferrite	<0.1	<0.05	FR4 PCB	0.21	0.01
Teflon	<0.1	<0.05	Black Liquid Crystal Polymer	0.41	0.11
Solder	<0.1	<0.05	3M Scotch-Weld 2216 B/A	0.77	0.04
Tantalum	<0.1	<0.05			

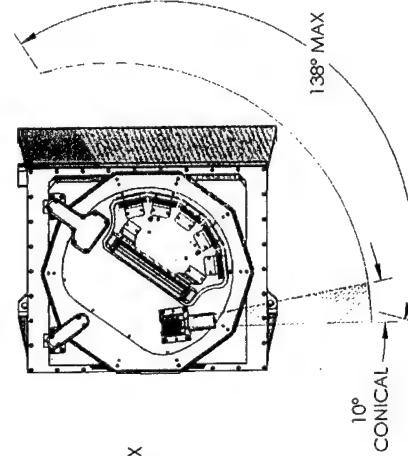
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Fields of View

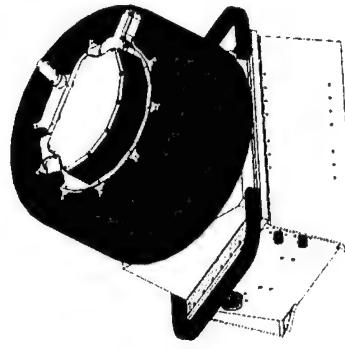
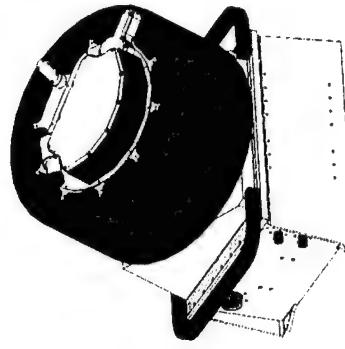
- Overlap between proton and heavy ion telescope



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04-12 MECHANICAL



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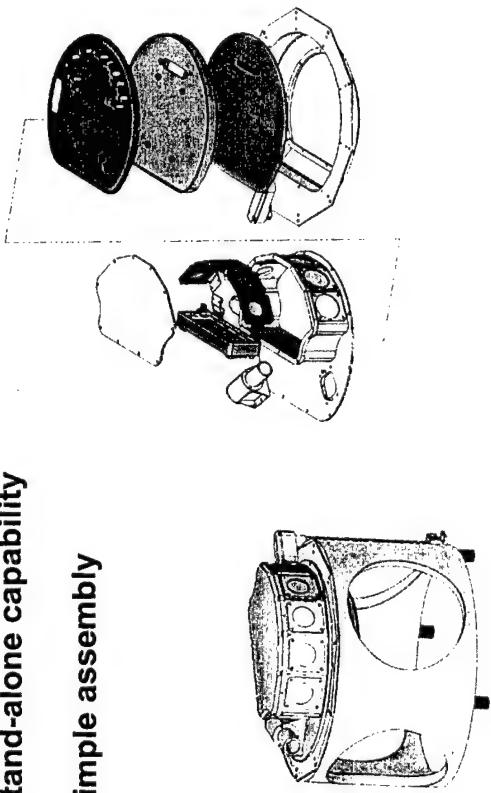
Handling

- Removable handles with captive screws
- SCM cover
- Ion telescope cover
- Proton telescope cover
- 15.7 lbs lift weight

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HiLET Features (1/2)

- Stand-alone capability
- Simple assembly

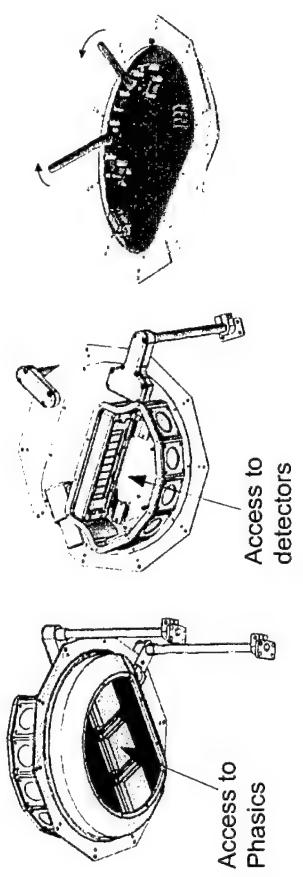


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HiLET Features (2/2)

- Access to circuit boards and detectors
- Board extraction using levers

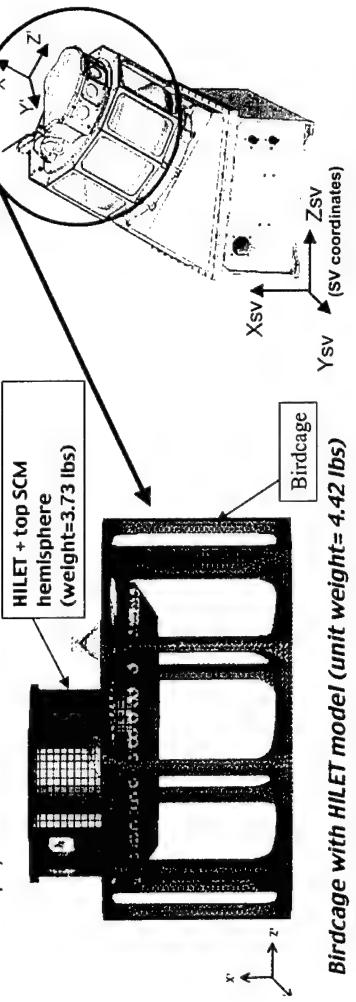


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DOS-SCM Structural Analysis Methodology

- Analysis performed to assess structural integrity due to changes from FM1 to FM2 flight units
- 3D finite-element model created for DOS-SCM FM2 assembly from base of Birdcage and up
 - 47,641 solid, shell, and beam elements for integrated model of Birdcage and HILET (includes PHA PWB, Detector PWB, Spacer Assembly, and three Phasic chips)



Birdcage with HILET model (unit weight= 4.42 lbs)

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FM2 DOS/SCM HILET Structural Analysis

15 January 2004

M. Papadopoulos/ Structures Dept
E. Pierre-Louis/ Mechanical Systems Dept
M. B. Van Dyke/ Environment & Ordnance Dept

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Vehicle Systems Division
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Birdcage with HILET model (unit weight= 4.42 lbs)

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DOS-SCM Structural Analysis Methodology

- Modal analysis conducted with MSC/NASTRAN Code to predict fundamental modes of critical components
- Static analysis with acceleration loading used to determine peak stresses
 - Single degree of freedom root mean square response, G_{rms} , employed to estimate peak G_s

$$G_{peak} = 3 * G_{rms} = 3 * \sqrt{\frac{1}{2} * \pi * PSD * f * Q}$$

/ Dynamic amplification (Q) of 20 assumed (based on FM1 random vibration test data from Birdcage)

- Qualification random vibration levels (+6 dB above Acceptance) used for analysis

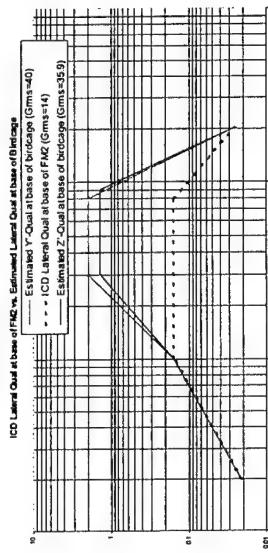
- Vibration input to base of Birdcage used for analysis
 - Derived from FM1 random vibration test data

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DOS-SCM Structural Analysis Methodology

- Derived Qualification vibration input spectrum based on FM1 test data
- Y'-, Z'- Lateral Axes**

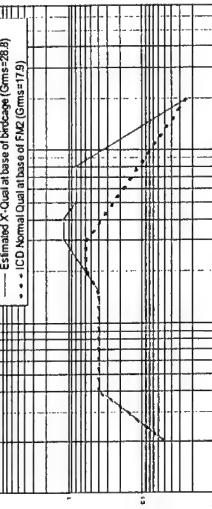


Y'-, Z'- Lateral Axes

ICD Lateral Quat at base of FM2 vs. Estimated Normal Quat at base of Birdcage
--- ICD Lateral Quat at base of Birdcage (Gms/s^2=40)
- - - ICD Lateral Quat at base of FM2 (Gms/s^2=14)
Estimated Y'-Quat at base of Birdcage (Gms/s^2=5.9)
Estimated Z'-Quat at base of Birdcage (Gms/s^2=5.9)

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X'- Normal Axis

ICD Normal Quat at base of FM2 vs. Estimated Normal Quat at base of Birdcage
--- ICD Normal Quat at base of Birdcage (Gms/s^2=28.8)
- - - ICD Normal Quat at base of FM2 (Gms/s^2=17.9)

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DOS-SCM Structural Analysis Methodology

- Stress margins of safety calculated using maximum of qualification-level random vibration or quasi-static design limit loads
- Detailed model of PWBs and Spacer (located within HILET structure) used for fatigue assessment of PHA PWB Phasic Chips
 - Three Kovar Phasic Chips
 - Spacer Assembly
 - PHA PWB
 - Kovar leads
 - Detector PWB (underside)

PHA PWB mass=316 grams
Detector PWB mass=164 grams
- Manson-Coffin fatigue equation used to relate predicted strain range of Kovar leads to cycles to failure
- Miner's rule used to estimate Cumulative Damage Index (CDI) under qualification vibration environment
 - / Allowable CDI of 1.0 with scatter factor of 4

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DOS-SCM Structural Analysis Results

- Analysis indicates DOS-SCM FM2 assembly of Birdcage and HILET can safely withstand qualification random vibration with proposed notches

Component	Material	Direction	Freq (Hz)	Notched Qual G	Peak Stress, psi @ Qual vib	Allowable, psi
Birdcage	Aluminum 6061-T6	Z	130	59	35,000	35,000 yd
		X	>2000	81	7,468	
		Y'	130	62	33,778	
HILET Top Plate	Aluminum 6061-T6	Z	130	57	30,189	
		X	681	399	25,715	35,000 yd
PHA Phasic Leads	Kovar	Y	130	61	26,248	
		X	522	140	44,564	50,000 yd
PHA PWB	Polymide	X	522	156	3,906	28,000 yd
Detector PWB	Polymide	X	522	191	4,208	28,000 yd

*Yield Margin = Allowable stress/(FS*Notched Peak Stress)-1
*Fatigue Margin = (1.0/CDI-1) (includes scatter factor of 4)

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Justification for Notched Vibration Test

- Analysis of original design indicated that PHA PWB would experience large deformations
- To reduce stresses on PHA PWB Phasic leads, sensitivity studies performed and following design modifications were incorporated to increase stiffness:
 - Number of attachment from PWBs to spacer increased from 2 to 6
 - Thickened spacer and enhanced spacer rib geometry
 - Increased PHA PWB thickness
- Even with modifications, analysis still predicted negative margins of safety for PHA PWB, Birdcage, and HILET Top Plate
- To prevent structural damage, notching at critical modes will be used
 - Notch levels derived to show zero yield and/or fatigue margin at qualification-level random vibration

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Peak G Response Limits

Axis / freq.	PHA Board Limit G peak	Birdcage Limit G peak	PQ Input Notch Depth (predicted)	PQ Input Notch Level g ² /Hz (predicted)	PQ Acoustic Test FM1 Response Envelope g ² /Hz
Z' / 130 Hz	-	42	5 dB	0.025	0.004
Y' / 130 Hz	-	45	4.5 dB	0.028	0.001
X' / 522 Hz	111	-	13 dB	0.006	0.0006

- 130 Hz is the predicted lateral Birdcage mode
- 522 Hz is the predicted PHA PWB fundamental bending mode
- Predicted input notch levels \geq 8 dB above the measured proto-qualification (PQ) SV system acoustic test response at the FM1 DOS/SCM base

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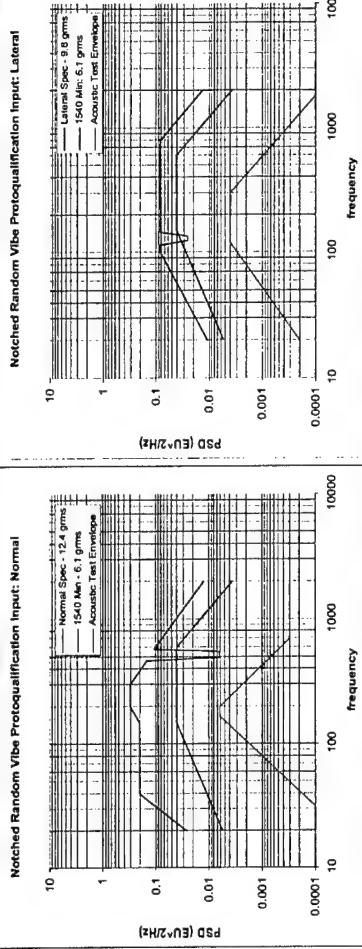
Additional Vibration Screen Test

- Before PQ test, additional test will be performed on DOS/SCM base (Birdcage removed) at MIL-STD-1540C minimum workmanship levels for 1 minute
- **Normal Axis:**
 - If notch determined in characterization test is no greater than predicted: no additional action is necessary
 - / Notch depth of 2 - 3 dB below minimum screen does not appreciably lessen the effectiveness of the screen
- If notch determined in characterization test exceeds prediction, additional workmanship test will be considered

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Predicted Input Notching



- **Notched test inputs envelope the expected proto-qualification system test/flight environment**
 - Notch levels are at least 8 dB above the levels measured at FM1 unit during system acoustic test

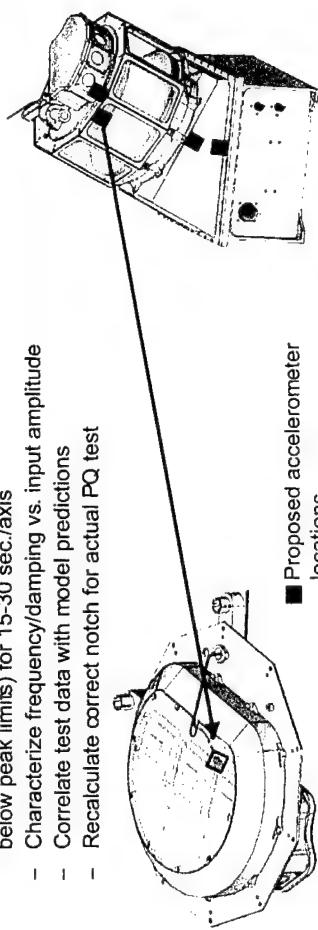
- **Notch depth falls below MIL-STD 1540C minimum workmanship screen guideline**
 - Lateral axis estimated notch is 2 dB below minimum screen level
 - Normal axis estimated notch level is 9 dB below minimum screen level

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Proposed Characterization Test

- **Characterization test needed due to inability to monitor PHA PWB notched response during PQ test on flight hardware**
- **Analysis indicates PHA PWB response critical to show positive fatigue margin**
- **Entire flight unit will be used for low-level random vibration test**
 - Use substitute cover plate with accelerometer cable access hole
 - PQ-18 dB (un-notched), PQ-12 dB, PQ-9 dB, PQ-6 dB (notched as necessary to 3 dB below peak limits) for 15-30 sec./axis
 - Characterize frequency/damping vs. input amplitude
 - Correlate test data with model predictions
 - Recalculate correct notch for actual PQ test



Structural Mechanics Subdivision
Vehicle Systems Division

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HiLET Detectors - Heavy Ion Sensor

- HiLET heavy-ion sensor uses custom silicon solid-state detectors
 - designed for NASA/STEREO mission
 - L1 (20 micron); L2 (50 micron); L3 (1000 micron)
 - Procured by Aerospace from Micron Semiconductor Ltd
 - Same detector specifications as STEREO
 - PO issued 8/2003
- Detector mounts procured by Aerospace (L1 & L2 - Pioneer Circuits; L3 - Rigiflex Technology Inc.)
 - STEREO mount design & specifications (courtesy of NASA/GSFC T. von Rosenvinge)
 - All mounts have been delivered to Aerospace
 - Ready for shipment to Micron after Aerospace Q/A

HiLET Detectors

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310-336-2389

06-1 DETECTORS

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Heavy Ion Sensor Detectors

1/3

- L1 design specification:
 - Thickness: 20 ± 2 microns
 - Thickness uniformity: ± 1 micron
 - Active area: 2 cm^2
 - Leakage current at 2 x full depletion: 10 nA typical 50 nA maximum
 - Full depletion: 3 V typical 10 V max
 - Operating voltage: FD to 2FD (50 V max)
- Number required for flight: 5
- Number of spares: 6

06-2 DETECTORS

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Heavy Ion Sensor Detectors

2/3

- L2 design specification:
 - Thickness: 50 ± 5 microns
 - Active area: $6.4 \times 1.6 \text{ cm}$ (10 elements)
 - Leakage current at 2 x full depletion: 100 nA typical 500 nA maximum
 - Full depletion: 10 V typical
 - Operating voltage: FD to 2FD (50 V max)
- Number required for flight: 1
- Number of spares: 2

06-3 DETECTORS

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06-4 DETECTORS

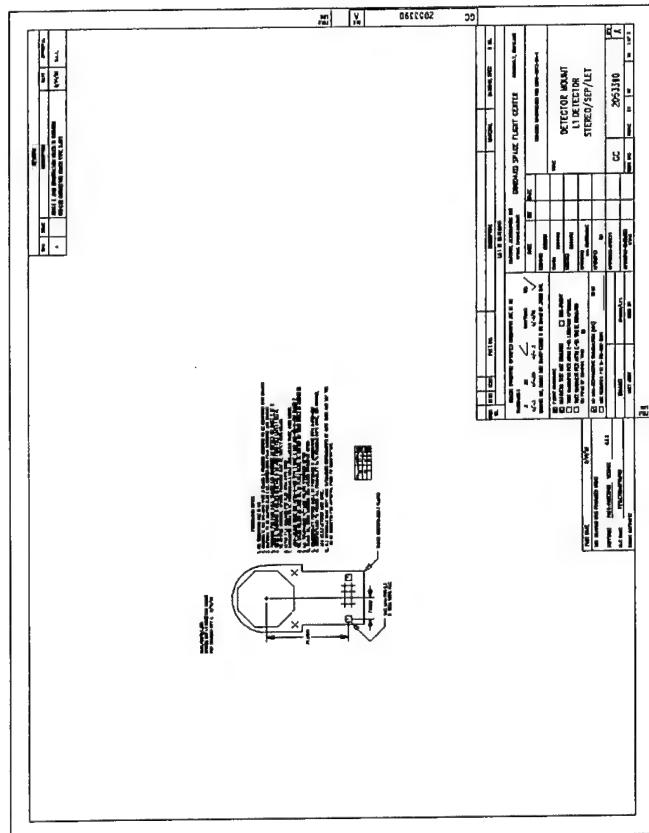
Heavy Ion Sensor Detectors

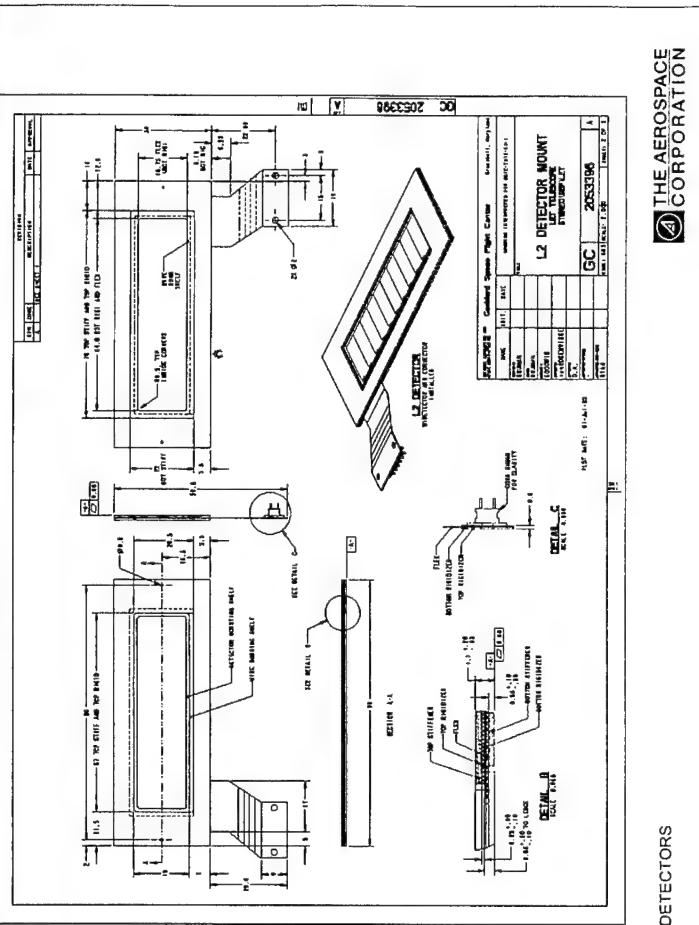
3/3

- L3 design specification:
 - Thickness: 1000 ± 50 microns
 - Active area: 7.8×2.0 cm (3 elements)
 - Leakage current at full depletion + 30 V: 500 nA typical
 - 2000 nA maximum
 - Maximum operating voltage: 200 V
 - Alpha resolution 100 keV FWHM
- Number required for flight: 2
 - Number of spares: 3

06-5 DETECTORS

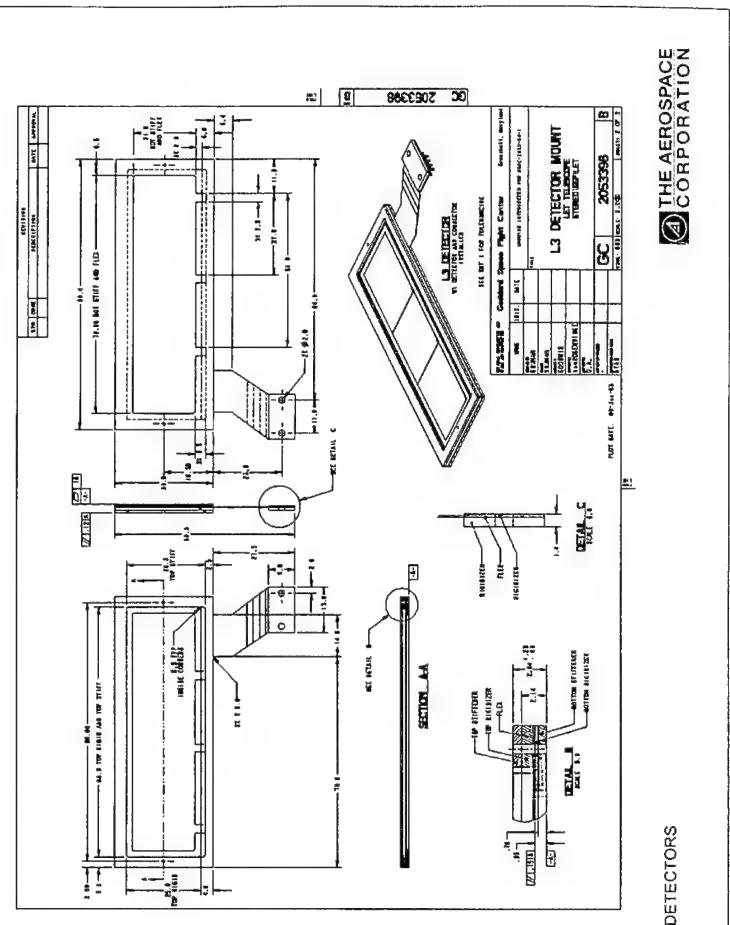
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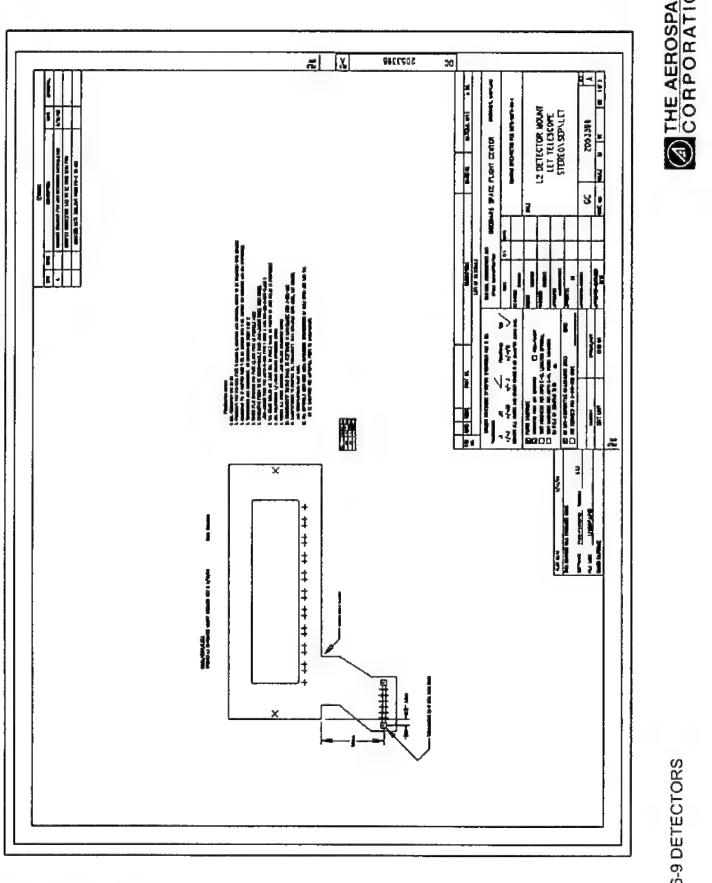
06-10 DETECTORS

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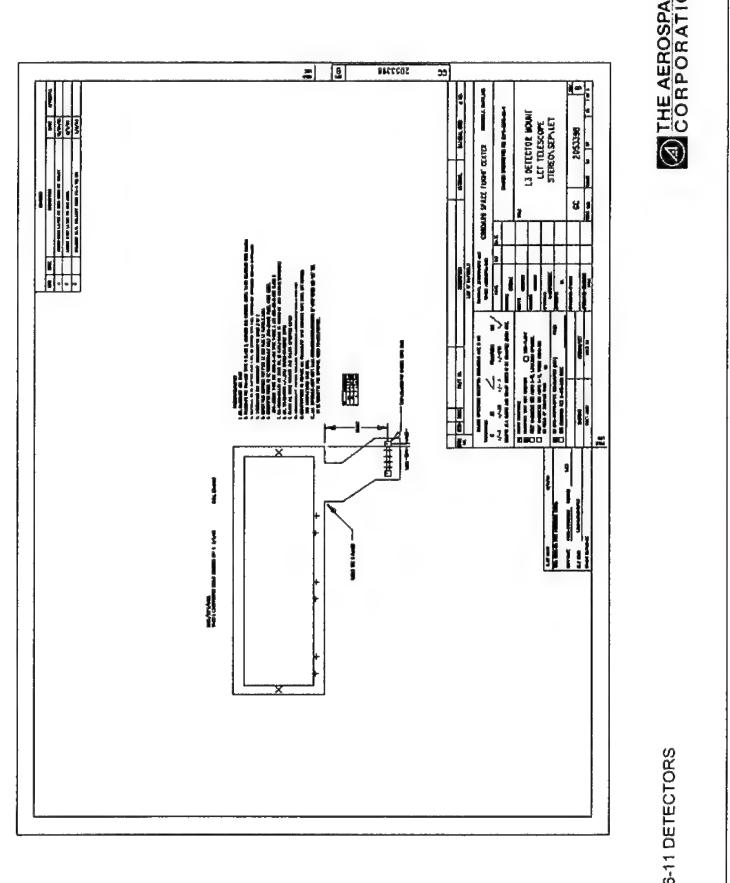
06-12 DETECTORS

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06-9 DETECTORS

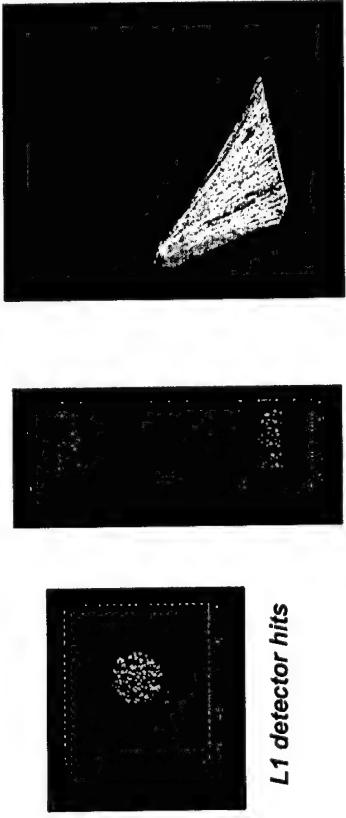
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06-11 DETECTORS

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Simulation of Particle Trajectories

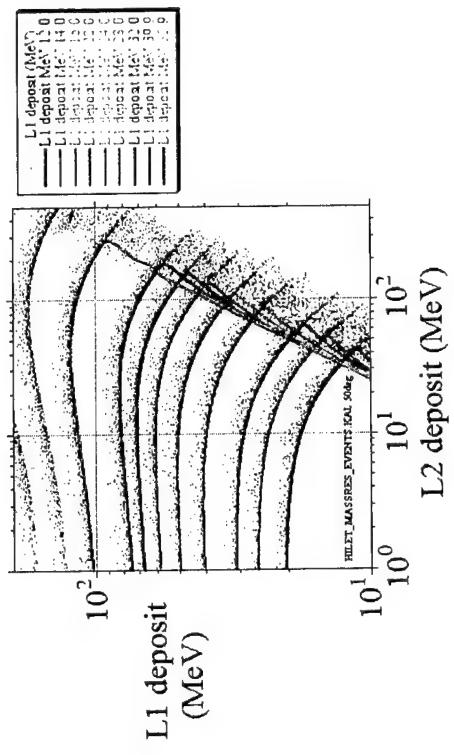


L1 detector hits L2 detector hits
Trajectories of valid L1L2 coincidences

06-15 DETECTORS

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HiLET - Simulated Response



06-14 DETECTORS

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Foils for Ion Sensor

- Requirements
 - Light tight to shield L1 detectors from sunlight
 - Thin to minimize low-energy threshold for heavy ions
 - Thermal radiator
 - Conducting exterior
- Specifications
 - 0.3 mil Kapton
 - Vacuum-deposited aluminum on inside surface
 - ITO on outside surface
 - Similar composition & size flown successfully on NASA/Wind

06-15 DETECTORS

06-16 DETECTORS

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Proton Sensor Detectors 1/3

- HiLET proton telescope uses silicon solid-state detectors designed for a previous NASDA mission
 - D1 & D2 (300 micron + solar blind window); D3 & D4 (1000 micron)
 - Procured by Aerospace from Micron Semiconductor Ltd
 - Mounts & detectors in stock at vendor
 - PO issued 11/2003

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Proton Sensor Detectors 2/3

- D1 & D2 design specification:
 - Part number: **MSD007-300** Type 7M
 - Thickness: **300 ± 15 microns**
 - Active area: **0.38 cm²**
 - Capacitance: **15 pf typical**
 - Leakage current at full depletion: **5 nA typical 20 nA maximum**
 - Alpha resolution (FWHM): **30 keV**
 - Full depletion voltage: **50 V maximum**
 - Operating voltage: **FD to 2x FD**
 - Ohmic window: **20000 angstrom solar blind Al**
- Number required for flight: **2**
- Number of spares: **2**

06-17 DETECTORS

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Proton Sensor Detectors 3/3

- D3 & D4 design specification:
 - Part number: **MSD008-1000** Type 2M
 - Thickness: **1000 ± 50 microns**
 - Active area: **0.5 cm²**
 - Capacitance: **22 pf typical**
 - Leakage current at full depletion: **100 nA typical 200 nA maximum**
 - Alpha resolution (FWHM): **30 keV**
 - Full depletion voltage: **250 V maximum**
- Number required for flight: **2**
- Number of spares: **2**

06-18 DETECTORS

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Detector Tally

Detector Type	# flight	# spares	Total	# mounts (ordered separately)
L1	5	6	11	32
L2	1	2	3	6
L3	2	3	5	8
D1 & D2	2	2	4	
D3 & D4	2	2	4	

- Total of **12** detectors for flight
- Total number of active pixels = **35**

06-19 DETECTORS

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Overview

- Functional Requirements
- Signal Processing
- Detector Interface
- Event Data Processing
- CPU Interface
- In-flight Diagnostic Capabilities
- Board Designs
- Power Supply Margins
- Parts
- Summary

Electronics

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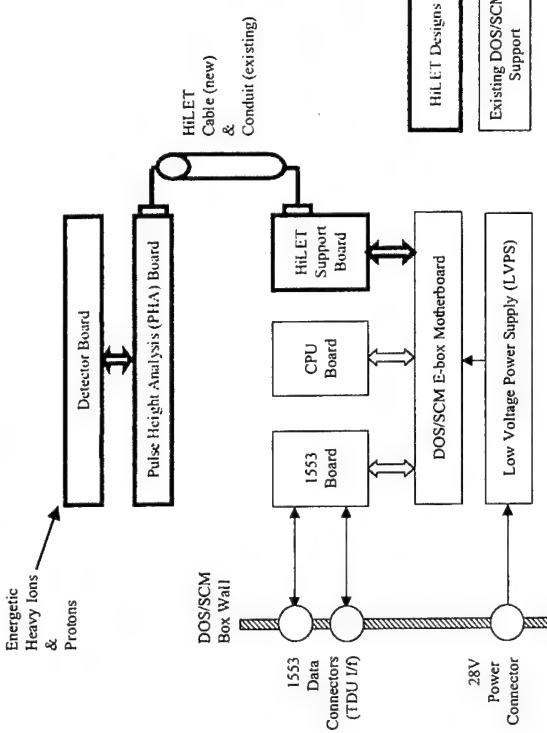
07-1 ELECTRONICS

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Functional Requirements

- Provide a pulse-height analysis system for a 31-element Heavy Ion Telescope and 4-element Proton Telescope
 - Leverage CalTech PHASIC hybrids
 - Satisfy E-range, resolution, threshold, and rate requirements
 - Implement coincidence logic for filtering background
- Provide in-flight diagnostic capabilities
- Provide a bus interface to DOS/SCM CPU
 - Generate detector bias voltages
- Operate on 5VDC, +/-5VDC, and +/-12VDC power sources

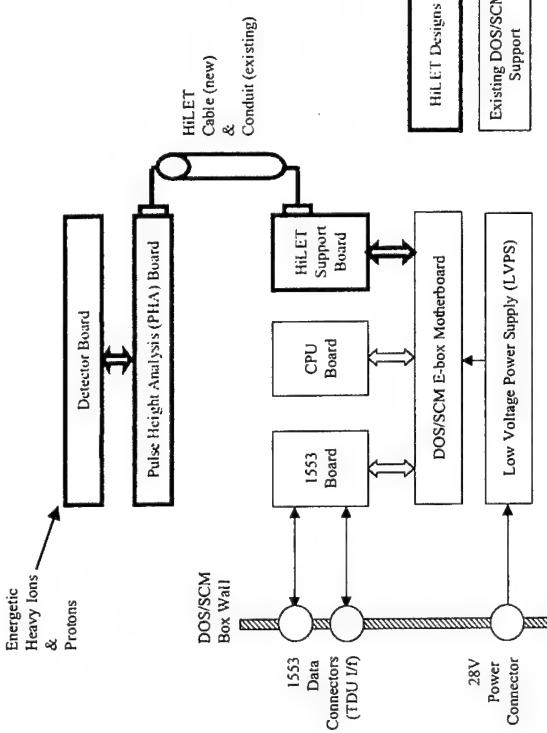
Functional Block Diagram



07-2 ELECTRONICS

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Functional Block Diagram



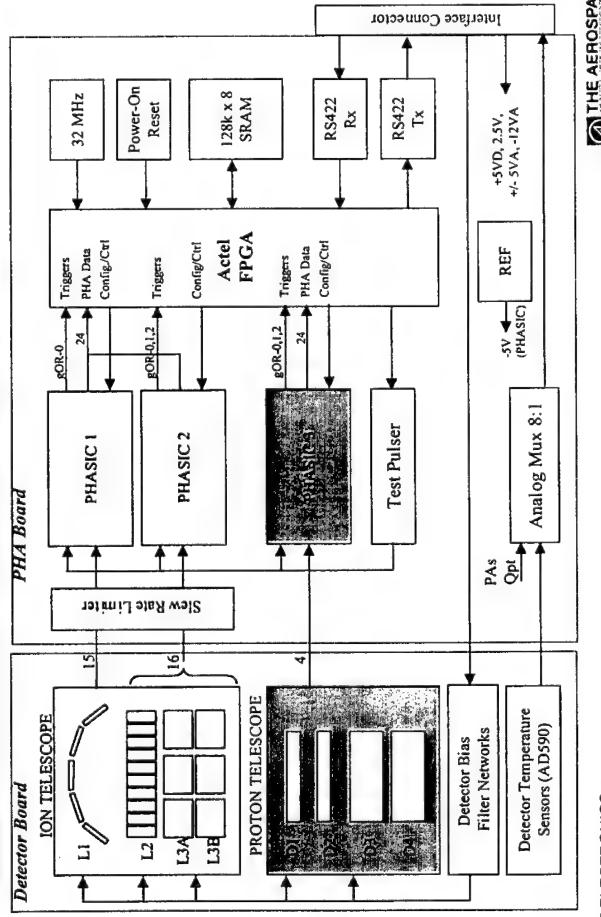
07-3 ELECTRONICS

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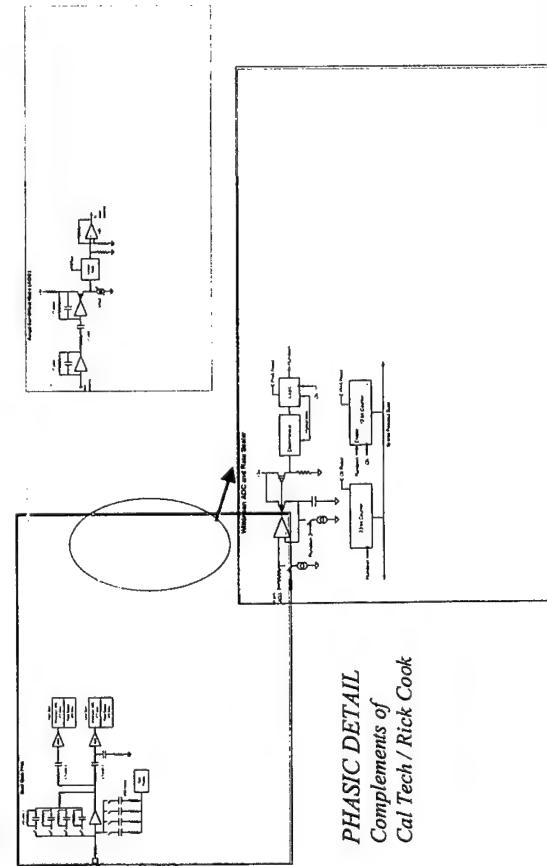
Functional Block Diagram

Signal Flow Diagram

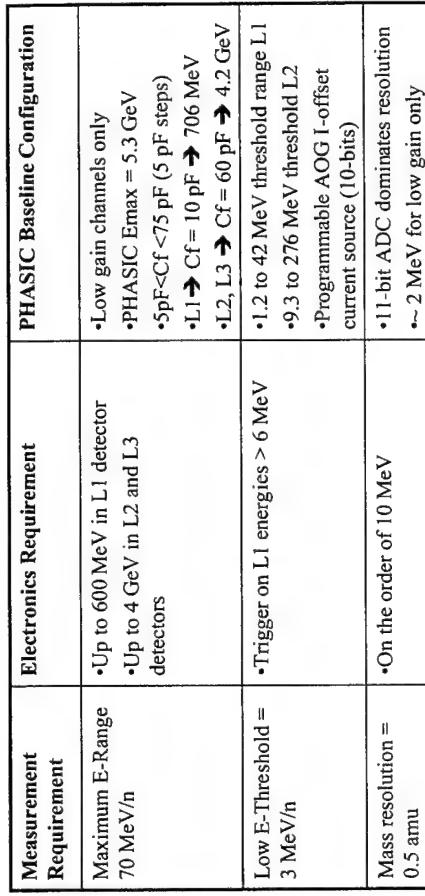
PHASIC Hybrid (1/2)



PHASIC Hybrid (2/2)



PHASIC DETAIL
Complements of
Cal Tech / Rick Cook



Ion Telescope Signal Processing

- PHASIC (Pulse Height Analysis System Integrated Circuit) designed by R. Cook, Cal. Tech.
- PHASIC heritage – NASA / ACE and STEREO
- Optimized for large signals, low power, and operational flexibility
 - 16 PHA signal chains
 - Preamplifiers can be tuned for various signal amplitude ranges, detector leakage currents, and input capacitance via serial command
 - High Gain and Low Gain Shaping amplifiers with 11-bit ADC for combined dynamic range of 10,000 (full scale / threshold)
 - 10-bit programmable low-level thresholds via serial command
 - 23-bit singles counter for each high and low gain PHA channel

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07-6 ELECTRONICS



SERVICES 13 20

Proton Telescope Signal Processing

- PHASIC configured in high gain mode will satisfy requirements for proton/alpha particle energy range and low energy threshold for electron data.

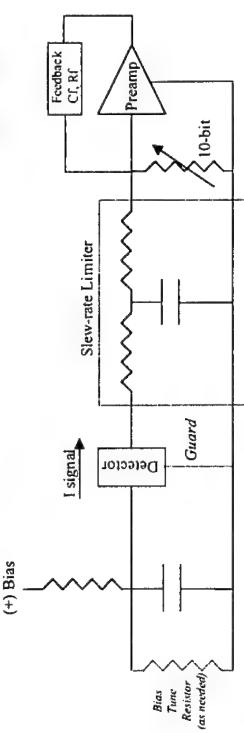
Measurement Requirement	Electronics Requirement	PHASIC Configuration
Expected maximum E-Range 20 MeV protons; retain capability for alphas	<ul style="list-style-type: none"> Max deposit in D1 and D2 detectors = 27 MeV Max deposit in D3 and D4 detectors = 54 MeV for alpha particle margin 	<ul style="list-style-type: none"> High gain channels only •PHASIC Emax = 265 MeV •$5pF < Cf < 75 pF$ (5 pF steps) •D1, D2 $\rightarrow Cf = 10 pF \rightarrow 35.4$ MeV •D3, D4 $\rightarrow Cf = 15 pF \rightarrow 53.1$ MeV
Low E-Threshold = 500 keV for electrons	Trigger on D1 energies above 500 keV	<ul style="list-style-type: none"> ~200 keV to 2 MeV threshold •Programmable I-offset current source (10-bits)

07-09 ELECTRONICS

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Detector Interface (1/2)

- Detectors are DC coupled
- Leakage current compensation provided by PHASIC 10-bit programmable shunt resistance
- Positive detector bias
- Positive detector bias
- Tuning resistor selected as needed to set detector bias; adds minimal power and noise
- Positive input signals
- Slew-rate limiting improves linear response and preamp stability for large signals

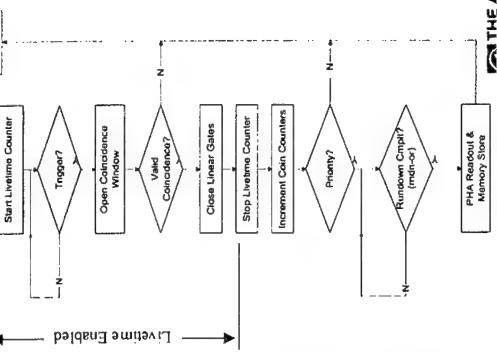


07-10 ELECTRONICS

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Event Processing (1/2)

- Dedicated FPGA logic performs event capture & readout @ 32 MHz
- Parallel event processing
- 24-bit Livetime counters for ion and proton sensors at 125 ns resolution
- Rate goal of 10 kHz is met



Rate Budget	Deadline
ADC _{PHASIC}	64 usec
Readout _{FPGA}	12 usec
Total	76 usec

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Detector Interface (2/2)

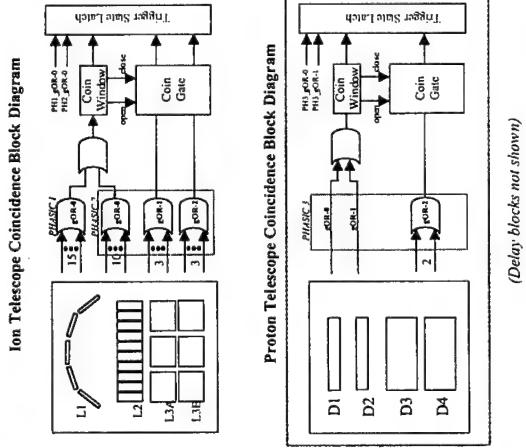
- Two bias supply circuits used to meet various detector depletion voltage requirements
 - Thick detectors are biased from 300V self-resonating supply used on FM1 Dosimeter.
 - Thin detectors are biased from low voltage multiplier circuit.
- Supply ranges & maximum loads estimated for worst-case detector leakage current and include added loading for shunt tuning resistance.

Detector Type	Detector Bias Range	Bias Supply Range	Max Load (uA)	Bias Supply Max load (uA)
L1	10V - 20V	11V - 34V	7.5	100
L2	10V - 20V	11V - 34V	20	100
L3A, L3B	200V - 230V	200V - 300V	21	50
D1, D2	50V - 100V	50V - 100V	44	100
D3, D4	200V - 250V	200V - 300V	21	50

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Event Processing (2/2)

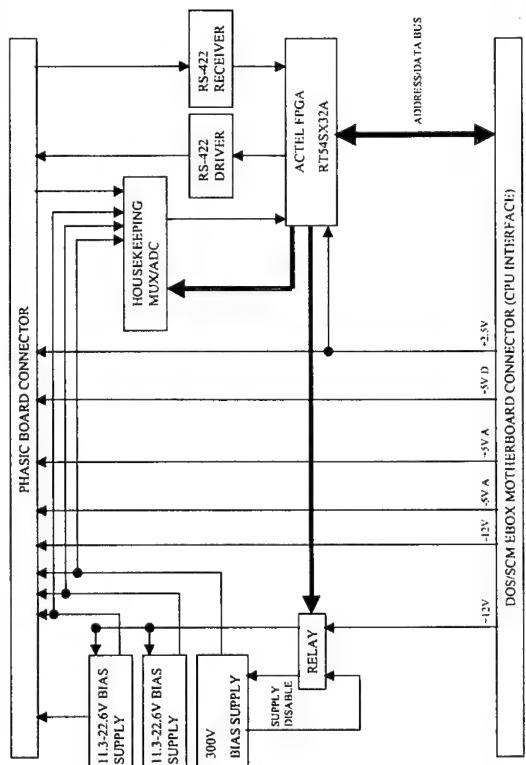
- Programmable coincidence window (32 ns to 10 us)
- Heavy ion logic
 - $L_1 \bullet L_2 \bullet L_3A \bullet L_3B$
 - $L_1 \bullet L_2 \bullet L_3A \bullet L_3B$
- Proton logic
 - $D_1 \bullet D_2 \bullet (D_3+D_4)$
 - $\overline{D_1} \bullet D_2 \bullet (D_3+D_4)$
 - $D_1 \bullet D_2 \bullet (D_3+D_4)$
- Direct event data (raw PHASIC data) stored if prioritizer accepts event
 - 24-bit singles rates from PHASIC



07-13 ELECTRONICS

CPU Interface

HiLET Support Board Block Diagram



07-14 ELECTRONICS

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PHA Board Description (1/2)

- Actel RT54SX72 includes event processing, coincidence logic, livetime counters, PHASIC control, matrix scalars, and Tx/Rx data interface
 - Module utilization is 43%
- Test pulser circuit consists of analog multiplexer to select one of four reference levels and is driven by op-amp
 - Analog conditioning for temperature monitors and detector leakage current measurements
 - Slew-rate limiter networks provide stabilization and improved large signal linearity of preamp, located near PHASIC inputs

In-flight Diagnostic Capabilities

- Test pulser adequately covers heavy ion and proton energy ranges (675 keV to 2.6 GeV)
- Dedicated heavy ion / proton detector temperature monitors
- Dedicated PHA board temperature monitor
- Detector leakage current monitoring provided by DC detector coupling and PHASIC preamplifier test output pin
 - On/Off control of detector biases

07-15 ELECTRONICS

07-16 ELECTRONICS

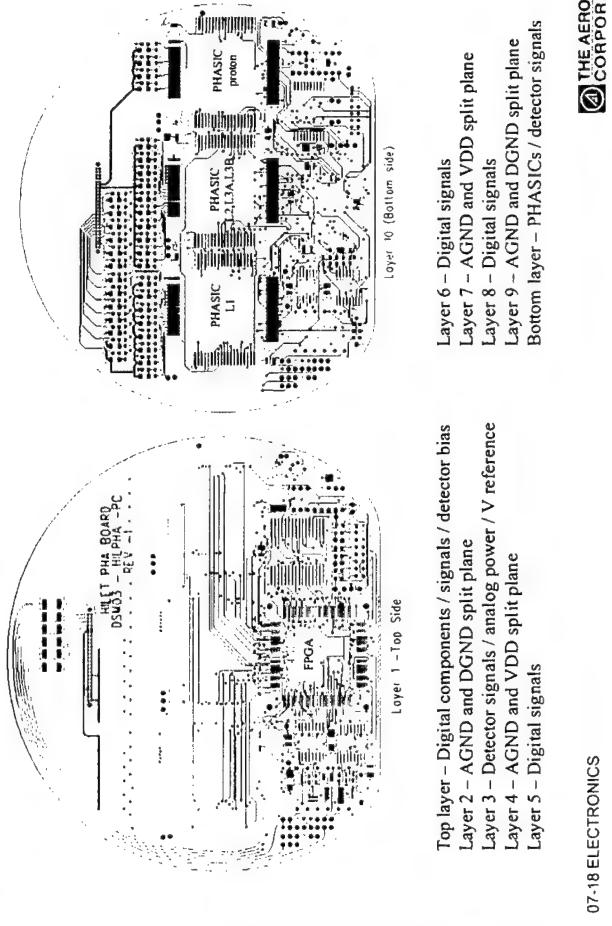
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PHA Board Description (2/2)

- Designed in accordance to MIL-STD-275
- Fabricated in accordance to MIL-STD-55110
- 10-Layer FR4-polyimide board ; 0.093 in.
 - Components placed on top and bottom of board
 - Both surface mount and through-hole components are used
- Pigtail harness between PHA board and DOS/SCM chassis
 - No blind solder joints

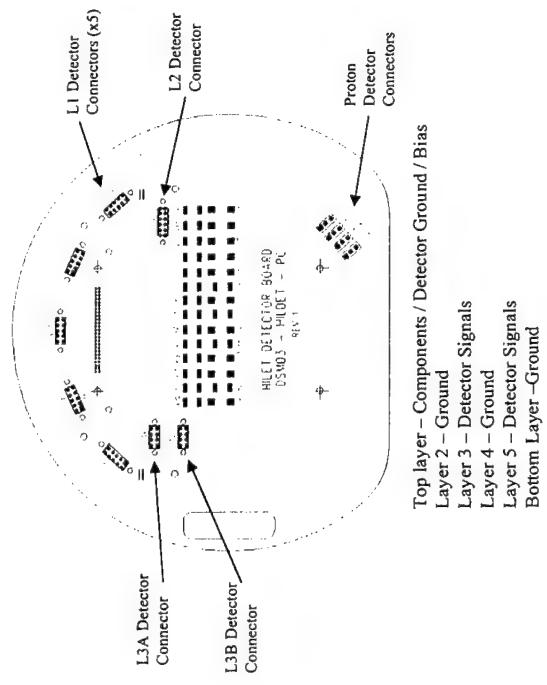
PHA Board Layout



Detector Board Description

- Designed in accordance to MIL-STD-275
- Fabricated in accordance to MIL-STD-55110
- Samtec connectors interface rigi-flex detector mounts and serve as interconnect to PHA board
 - Two AD590 temperature sensors located near Heavy Ion “L1” and Proton “D” detector mounts
 - Includes detector bias-tuning resistors and filter capacitors
 - 6-layer FR4-polyimide printed circuit board
 - No blind solder joints

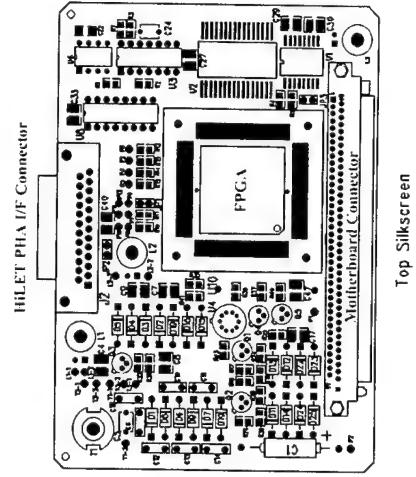
Detector Board Layout



HiLET Support Board

HiLET Support Board Layout

- RT54SX32 device provides a memory-mapped CPU interface for HiLET
 - Module utilization is 50%
- Controls serial RS422 Tx/Rx interface to PHA board
- Supplies Thick/Thin detector biases with On/Off control
- Digitizes analog housekeeping
- 8-layer printed circuit board
 - Conforms to existing DOS/SCM E-box mechanical requirements and Motherboard electrical interface
- No blind solder joints



07-21 ELECTRONICS

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07-22 ELECTRONICS

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Power Supply Margin

Added current demand has no impact on LVPs design

HiLET Board Name	5V	+5V	-5V	+12V	-12V	mA	mA	mA	mA
DPU boards & SCM	380	380	73	73	103				
HiLET Detector Board	0	0	0	0	0				
HiLET PHA Board	204	98	21	0	12				
HiLET Support Board	108	0	0	4	0				
Total Estimate	692	478	94	77	115				
LVPs NTE	2400	650	650	625	625				

07-23 ELECTRONICS

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Grounding

- Grounding scheme is the same as FM1
- S/C 28-volt return is isolated from LVPs secondary grounds by greater than 100 Meg-ohms
- LVPs secondary returns are common at motherboard, are connected electrically to the chassis, and are routed as Analog ground and Digital ground to boards
- HiLET detector returns are routed to the PHA board PHASIC ground pins and are locally isolated from chassis

07-24 ELECTRONICS

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Electronic Parts (1/2)

- HiLET parts program conforms to FM1 standards
- All microcircuits procured to MIL-STD-883B as a minimum; most are QML class V
- No commercial grade or plastic parts
- PHASICs screened to hybrid class H
- All diodes and transistors are JANNTXV or better
- Capacitors and resistors are Class S
- Radiation tolerant parts are used throughout
- All diodes and transistors are JANNTXV or better
- Capacitors and resistors are Class S
- Radiation tolerant parts are used throughout
 - 100 krad minimum hardness
 - PHASICs are tolerant to 12 krad and spot shielded for 10 year life
 - No latchup
 - No SEU < 1 bit error in 10 years

07-25 ELECTRONICS

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Electronic Parts (2/2)

PHA Board Part Types				Support Board Part Types			
QTY	PART NUMBER	DESCRIPTION	MANUFACTURER	QTY	PART NUMBER	DESCRIPTION	MANUFACTURER
2	C0R06B0000AKWVS	CAPACITOR	KEMET	2	M390C01254S	CAPACITOR	KEMET
21	C0R33B0000AKWVS	CAPACITOR	KEMET	30	C0R33B0000AKWVS	CAPACITOR	KEMET
35	C0R32B0000AKUS	CAPACITOR	KEMET	6	C0R33B0000AKUS	CAPACITOR	KEMET
6	CWRY1K1K000KB	CAPACITOR	KEMET	6	C0R33B0000AKUS	CAPACITOR	KEMET
1	C0R54X00F250AC	CAPACITOR	KEMET	2	C0R33B0000AKUS	CAPACITOR	KEMET
1	JANTXV1M4150-1	DIODE	ACI	2	C0R33B0000AKUS	CAPACITOR	KEMET
96	M45342K0063K000S	RESISTOR	S.O.T.A.	1	C0R32B0151B1MWS	CAPACITOR	KEMET
6	M45342K0501VAC	RESISTOR	S.O.T.A.	1	JANTXV1M4150-1	DIODE	KEMET
1	5650R866501VAC	HS26C31RH	INTERSEL	16	JANTXV1M4150-1	DIODE	MICROSEMI
1	RT5150Z5-1CC2098	PH4 FPCA	ACTEL	4	JTX1N5527B-1	CONNECTOR	MICROSEMI
3	PHASIC	PHASIC	ACI TECH	1	RM422-080-210-0256	CONNECTOR	AIRBORNE
1	H6222 SRAM	RAM	HONEYWELL	1	M8513/19-DOINP	TRANSISTOR	GLENAR
1	C0451B1KWS	CD451B1KWS	INTERSEL	4	JANTXV2N222A	TRANSISTOR	MICROSEMI
1	SFM425-025-L0	CONNECTOR	SAMTEC	1	JANTXV1M4150-1	RESISTOR	SOTAK
1	AD590LF17883B	AD590LF TEMP ADCR	ANALOG DEVC	33	M5342K0063K000S	INTERSEL	INTERSIL
1	AD5870TD17883B	AD5870 TDAC	ANALOG DEVC	1	HS26C31RH	HS26C31RH	HONEYWELL
1	CD40106B	CD40106B	HARRIS	1	HS26C31RH	HS26C31RH	ANALG DEVCES
1	HS26C31RH	HS26C31RH	INTERSEL	1	AD53175D-VIF	AD53175D-VIF	TELEDYNE
1	SS62R866501VAC	AD584 REFERENCE	ANALOGDEV	1	EN422 RELAY	EN422 RELAY	ANALG DEVCES
1	AD5874H863B	OSCILLATOR	QTECH	1	AD712 OPAMP	AD712 OPAMP	INTERSEL
1	NCM480-1M	Detector Board Part Types	INTERSEL	1	C0R32B0151B1MWS	C0R32B0151B1MWS	ACTEL
10	SA202B/232K-020AM	HV CAPACITOR &R HV	MANUFACTURER	1	HS26C31RH	HS26C31RH	ACTEL
1	SDW-104-01-L0	CONNECTOR	KEMET	1	RT5150Z5-1CC2098	RT5150Z5-1CC2098	ACTEL
1	CLT-104-01-L0	CONNECTOR	SAMTEC				
1	THK-125-02-L0	CONNECTOR	SAMTEC				
4	ESS-103-01-G3	CONNECTOR	SAMTEC				
5	SDW-105-01-L0	CONNECTOR	SAMTEC				
18	M5342K0063K000S	RESISTOR	ANALOG DEVC				
2	AD590LF17883B	AD590LF TEMP ADCR	ANALOG DEVC				

07-26 ELECTRONICS

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Parts Derating (1/2)

- NASA PPI-21 de-rating factors used as a guideline in assessing SSAL class A designs
- De-rated parameters from manufacturer's maximum operating specifications
- The following parts comply fully with PPL-21 guidelines
 - Microcircuits power consumption and output current in compliance
 - Capacitor voltage de-rating in compliance
 - Resistors power consumption and voltage derating in compliance
 - Diodes PIV, surge current, and forward current derating in compliance
 - Transistors power, current, and voltage derating in compliance
 - Relay load current in compliance
 - HiLET connectors slightly exceed de-rating guideline
 - See next chart

Parts Derating (2/2)

- PHA I/F connector voltage exceeds derating guideline
 - Part Type: Glenair 25-pin micro-miniature connector
 - Discrepancy: DWV is 900 volts AC at sea-level; Derated maximum is 225 volts; HiLET maximum voltage is 300 volts DC on this connector
 - Justification: Use as is; operate 300 volt supply only in vacuum; HiLET voltage is DC
- Detector board interface connector voltage exceeds derating guideline
 - Part Type: Samtec SFM/TFM style connectors
 - Discrepancy: DWV is 1050 volts AC at sea-level; Derated maximum is 262 volts; HiLET maximum voltage is 300 volts on this connector
 - Justification: Same as above

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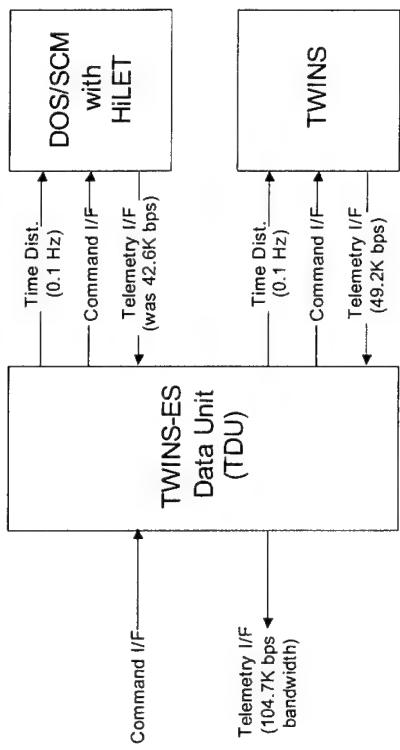
07-28 ELECTRONICS

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Summary

- Heavy Ion Telescope leverages STEREO development and meets requirements
- Proton Telescope meets requirements using PHASIC chip
 - Good resource margin in FPGAs
 - No critical parts issues

TWINS-ES Software Elements & Interfaces



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TWINS-ES FM2 Flight Software Modifications for HiLET

Dan Mabry
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TDU Software Modifications (FM2)

- HiLET support (commands, telemetry)
 - Added HiLET 1553 subaddress for telemetry passage
 - Added 402 bytes/second HiLET telemetry
 - Commands added to support HiLET calibration
 - HiLET configuration changes rely on existing memory load features
- Perigee data products and packets for HiLET, LAD, and SCM
- TDU software modifications were verified with simulators for HiLET and TWINS prior to delivery

08-1 SOFTWARE

08-2 SOFTWARE

HiLET Telemetry Packet

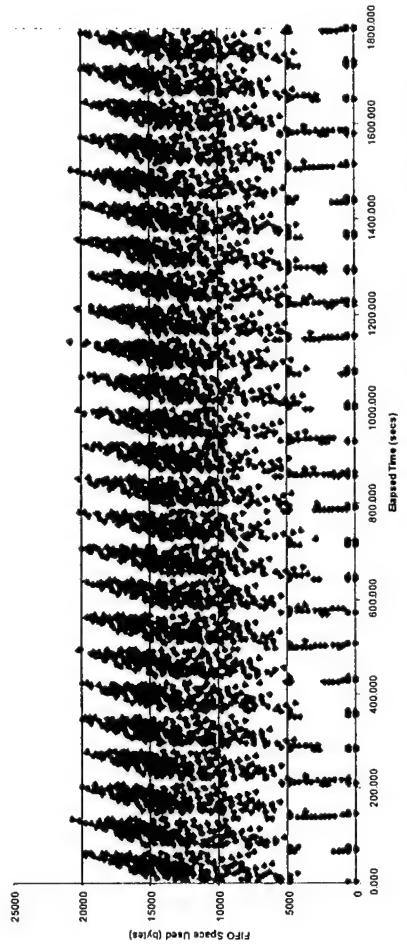
HiLET Data Packet Contents		
Start Byte Number	Data Element	# of Bytes
1	Primary Header	6
7	Secondary Header	6
13	D1-D4 (proton) singles data (msb first)	12
25	L1 (heavy ion) singles data, 15 detectors	45
70	L2, L3A/L3B singles data, 16 detectors	48
118	Coincidence rates (Dx, Lx)	18
136	Lifetime rates (Dx, Lx)	6
142	Matrix Rates	33
175	Number of valid direct events	1
176	Direct event storage	226
402	Checksum	

Packet transmitted once per second
Telemetry requirement = 3.24K bps

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TDU Perigee Data Processing

- Real-time data from TWINS and DOS/SCM parsed and stored according to hard-coded algorithms
- New hardware memory buffer in TDU FM2 provides 3 hour ring-buffer storage for selected datasets
 - HiLET: all data stored (10800 packets @ 1 sec res.)
 - TWINS/LAD: all data stored (600 packets / 3 hrs)
 - SCM: 1 HV step-anode value per 5 msec (5714 pkts / 3 hrs)
- Ring buffers are maintained throughout orbit
- One ground command causes dump of ring buffer data
- Idle interface times are used for perigee data transfer; real-time data has highest priority for telemetry transmission



Telemetry bandwidth simulations performed for all TDU, TWINS, and DOS/SCM data sources for a 30 minute period show that all data is successfully output, along with perigee data and HiLET packets, while staying safely below the 24.5K byte FIFO limit.

TDU Telemetry Bandwidth Assessment

DOS/SCM Software Reqs. (from FM1)

- Perform stepping control of SCM high voltages. Collect, compress timestamp, and telemeter SCM data packets to TDU
 - Collection/stepping interval is 5 msec
 - Data generation rate is 41.68 Kbits/second
 - Stepping tables are stored in EEPROM
- Receive, validate and process ground commands and memory loads from TDU (spacecraft)
- Build and transmit housekeeping packets once per second
- Maintain TDU-synchronized time

New HiLET Software Requirements

- Add readout and control support for the HiLET sensor
- Augment TDU/1553 architecture to include new HiLET data packets
- Provide non-volatile storage for HiLET look-up table (64K bytes) and configuration information (~320 bytes)

DOS/SCM Software Architecture

- Software design uses a single hardware interrupt (5 msec) – same as FM1 architecture
- Interrupt uses
 - Defines integration interval for SCM data collection and high voltage stepping
 - Derives time intervals for HK output and HiLET data collection
 - New in FM2, is used to receive time broadcast from the TDU to maximize time correlation between DOS/SCM and TDU
 - Background task modified to incorporate HiLET data processing on 1-second boundaries

08-9 SOFTWARE

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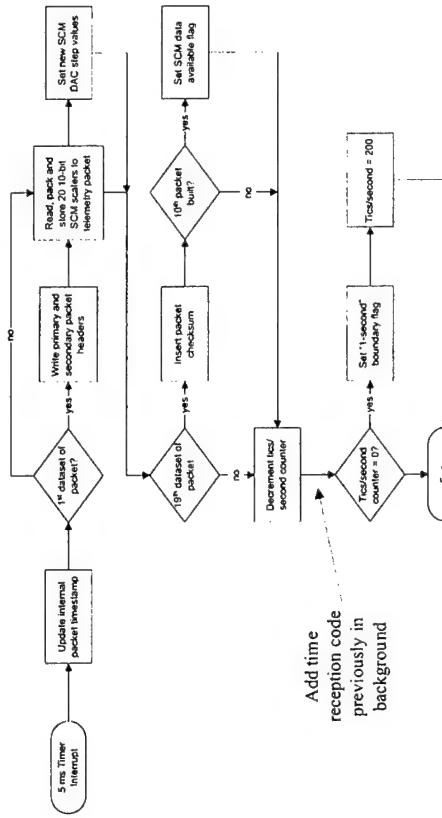
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08-10 SOFTWARE

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DOS/SCM 5ms Interrupt Service Routine



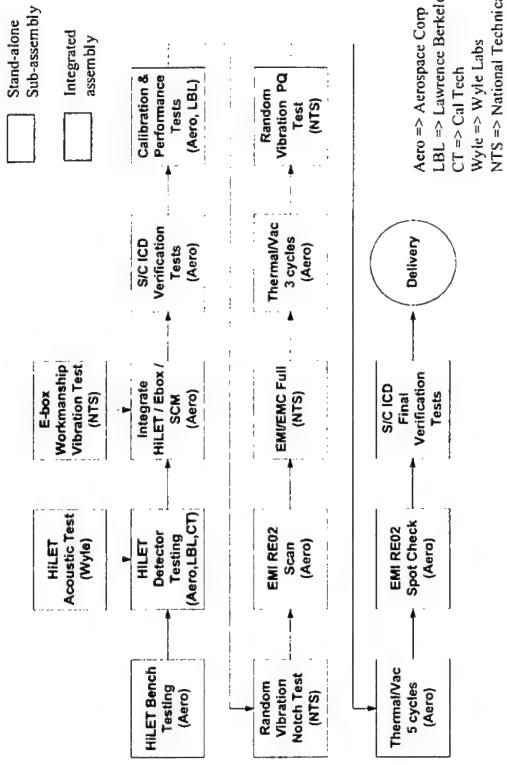
Direct Event Selection Algorithm

- Telemetry space allocated for direct event (DE) storage is 226 bytes per second
- Direct event double-buffer maintained in HiLET support board
 - Stores 226 bytes for direct event storage
 - Events are tagged as either protons or electrons
- Three-pass data selection algorithm
 - First pass: traverse data buffer selecting “programmed minimum” of proton events
 - Second pass: traverse data buffer filling output with heavy ion data
 - Third pass: put any remaining proton events into telemetry buffer

HiLET Processing Impact

- Coding is complete on HiLET direct event processing code
- Calculations performed with assumptions as follows
 - All events received are 7 bytes in length
 - Minimum number of protons for output is 5
 - 700 events of each type are received from support PCB
 - All events must be checked to locate a “small” event
 - Result shows execution time of direct event processing is 51 msec per second
 - Calculations show CPU is 39.2% utilized with HiLET added

Test Sequence



09-2 TEST PLAN

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Test Plan

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09-1 TEST PLAN

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Random Vibration Tests

- Notch characterization test will validate structural model
- E-box will be screened at MIL-STD-1540 minimum workmanship levels for one minute on normal axis (and lateral if necessary) prior to integration with HiLET
- Integrated instrument will be tested to proto-qualification levels on three axes (3dB above program acceptance levels) with notching
- Instrument will be un-powered during vibration
- Functional test will be performed before and after vibe
- Executed at NTS

Acoustic Test

- External detector/foil assemblies warrant acoustic test
- Proto-qualification test will be performed on the HiLET assembly
 - Two minute duration
 - No SCM or E-box
 - Flight-like L1 detectors and foils installed
 - Unpopulated PCBs installed

EMI / EMC Tests

- Initial radiated emissions test, s/c bus leakage test, and final spot check performed in Aerospace Labs screen room
- Radiated emissions verified at beginning and end of environmental testing
- Susceptibility testing and formal radiated emissions test performed at NTS

Thermal Vacuum Test

- Split test (3 cycles / 5 cycles) gives early detection of workmanship problems
- Test temperatures will incorporate 10-degree margins on analytical hot and cold predictions
- Survival soak at instrument design limit and pre-test soak time incorporated
- Functional test performed at Hot/Cold on each cycle
- Performed at Aerospace

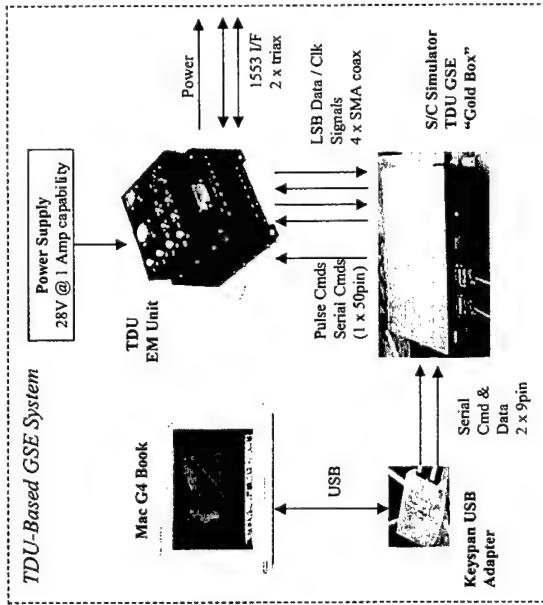
09-5 TEST PLAN

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09-6 TEST PLAN

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GSE Configuration (1/2)



09-7 TEST PLAN

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09-8 TEST PLAN

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GSE Configuration (2/2)

- TDU-based GSE
 - DOS/SCM & HILET integrated testing
 - Used throughout environmental test flow
 - Functional and EMC tests
 - Final calibration
- HILET Stand-alone GSE
 - Initial checkout of HILET electronics
 - Detector testing

Functional Tests (1/2)

- Comprehensive Test Procedure
 - Validates housekeeping monitors
 - Telemetry & commands
 - Flight software (DPU modes, uploads, macros, etc.)
 - SCM high voltage/thresholds/counts/data
 - HiLET detector biases/thresholds/counts/data
 - Performed at critical points throughout environmental testing
 - Utilizes both automated and manual checkpoints
 - STOL script-driven GSE automatically checks telemetry

Functional Tests (2/2)

- Data is stored in GSE computer as raw telemetry and can be replayed for 100% historical record
 - All commands and out-of-spec items are logged in GSE computer
 - Test times and results are logged in DOS/SCM Log Book
 - Formal reports written for ICD verification test items
- Utilizes both automated and manual checkpoints
 - STOL script-driven GSE automatically checks telemetry

HiLET Programmatics

Project Programmatics

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10-1 PROGRAMMATICS

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- Status & milestones
- Risk assessment

Status/Milestones

- Structural analysis completed
- Thermal analysis completed
- Mechanical & electrical designs completed
- Test plan developed
- Long-lead parts either on order or in-house

10-3 PROGRAMMATICS

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10-4 PROGRAMMATICS

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Board Status

Instrument	Boards	Design	Layout	Fabrication	Status	Traveler & Parts Kitting	Assembly	Test
HiLET	IPASIC Chip Test	X	X	X	X	X	X	X
HiLET	IPHA	X	X	X	X	X	X	X
HiLET	Support	X	X	X	X	X	X	X
HiLET	Detector	X	X	X	X	X	X	X
DOSSOM System	Mother Board	X	X	X	X	X	X	X
DOSSOM System	CPU	X	X	X	X	X	X	X
DOSSOM System	1553 Interface	X	X	X	X	X	X	X
DOSSOM System	Low Voltage Power Supply	X	X	X	X	X	X	X
SOM	Anode	X	X	X	X	X	X	X
SOM	Support	X	X	X	X	X	X	X
SOM	High Voltage Stepper	X	X	X	X	X	X	X
SOM	High Voltage Stabil	X	X	X	X	X	X	X

X = Complete

10-2 PROGRAMMATICS

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Long-Lead Parts Status

- HiLET solid state & proton detectors
 - Estimated delivery 3/15/04
- ACTEL gate arrays
 - Delivered 1/04

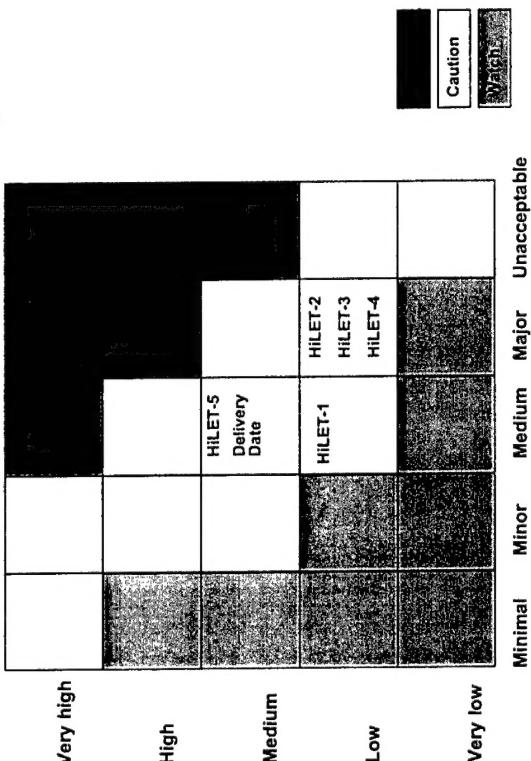
Risk Assessment (1/2)

Item	Risk	Risk Type	Impact	Probability	Mitigation
HiLET - 1	Mass will grow beyond allocation	Technical	Medium	Low	Make instrument smaller by decreasing number of detectors
HiLET - 2	Instrument violates EMI spec	Technical	Major	Low	EMI awareness incorporated into design from the start
HiLET - 3	Dynamic amplification factor (Q) much larger than assumed in structural analysis	Technical	Major	Low	Determine Q in early notch characterization test
HiLET - 4	~50% of L3 detectors for STEREO same design & manufacturer as for HiLET found to have unacceptable leakage currents.	Technical	Major	Low	Early detector screening.
HiLET - 5	Detectors delivered behind schedule	Schedule	Medium	Medium	Regular contact with Micron. Borrow spare detectors from C11 for beginning of HiLET test program.
Delivery Date	Backlog in machine shop	Schedule	Medium	Medium	Submit drawings early. Use external shop as needed.

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10-6 PROGRAMMATICS

Risk Assessment (2/2)



Probability of occurrence

Impact

10-7 PROGRAMMATICS

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Summary

- As part of DOS/SCM FM2, the proposed HiLET design will provide ion measurements for
 - Improving decades-old environmental models
 - Support of solar array design
 - Improving SEE specification & prediction
- Structural & thermal analyses complete
- Thorough test plan, including notch characterization
 - Detectors are the only long-lead items
 - Risk items identified and tracked
 - Ready to build HiLET flight hardware

12-2 SUMMARY

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Closing Remarks

Joe Mazur

12-1 SUMMARY

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